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Low-Power, 2-Channel, 16-Bit Analog Front-End for Biopotential Measurements

Check for Samples: ADS1191, ADS1192

FEATURES

 Two Low-Noise PGAs and Two High-Resolution ADCs (ADS1192)

Low Power: 335 μW/channel
 Input-Referred Noise: 24 μV_{PP} (150-Hz BW, G = 6)

Input Bias Current: 1 nA

Data Rate: 125 SPS to 8 kSPS

CMRR: -95 dB

Programmable Gain: 1, 2, 3, 4, 6, 8, or 12

Supplies: Unipolar or BipolarAnalog: 2.7 V to 5.25 VDigital: 1.7 V to 3.6 V

 Built-In Right Leg Drive Amplifier, Lead-Off Detection, Test Signals

Built-In Oscillator and Reference

Flexible Power-Down, Standby Mode

SPI™-Compatible Serial Interface

Operating Temperature Range: –40°C to +85°C

APPLICATIONS

- Medical Instrumentation (ECG) including:
 - Patient monitoring; Holter, event, stress, and vital signs including ECG, AED, telemedicine
 - Sports and fitness (heart rate, respiration, and ECG)

DESCRIPTION

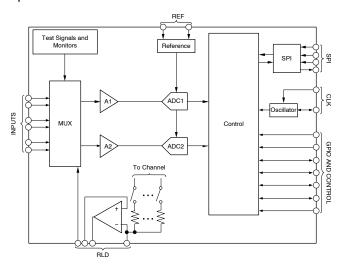
The ADS1191/2 are a family of multichannel, simultaneous sampling, 16-bit, delta-sigma ($\Delta\Sigma$) analog-to-digital converters (ADCs) with a built-in programmable gain amplifier (PGA), internal reference, and an onboard oscillator.

The ADS1191/2 incorporate all of the features that are commonly required in portable, low-power medical electrocardiogram (ECG), sports, and fitness applications.

With its high levels of integration and exceptional performance, the ADS1191/2 family enables the creation of scalable medical instrumentation systems at significantly reduced size, power, and overall cost.

The ADS1191/2 have a flexible input multiplexer per channel that can be independently connected to the internally-generated signals for test, temperature, and lead-off detection. Additionally, any configuration of input channels can be selected for derivation of the right leg drive (RLD) output signal. The ADS1191/2 operate at data rates up to 8 kSPS. Lead-off detection can be implemented internal to the device, using the device internal excitation current sink/source.

The devices are packaged in a 5-mm \times 5-mm, 32-pin thin quad flat pack (TQFP). Operating temperature is specified from -40° C to $+85^{\circ}$ C.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

FAMILY AND ORDERING INFORMATION(1)

| PRODUCT | PACKAGE OPTION | PACKAGE DESIGNATOR | NUMBER OF CHANNELS | ADC RESOLUTION | MAXIMUM SAMPLE RATE (kSPS) | OPERATING TEMPERATU RE RANGE | RESPIRATION CIRCUITRY |
|-----------------------|-------------------|-----------------------|-----------------------|-------------------|----------------------------------|------------------------------------|--------------------------|
| A D C 4 4 0 4 I D D C | TQFP | PBS | 1 | 16 | 8 | -40°C to +85°C | No |
| ADS1191IPBS | QFN | RSM | 1 | 24 | 8 | -40°C to +85°C | No |
| A D C 4 4 0 0 I D D C | TQFP | PBS | 2 | 16 | 8 | -40°C to +85°C | No |
| ADS1192IPBS | QFN | RSM | 2 | 24 | 8 | -40°C to +85°C | No |
| ADS1291IPBS | TQFP | PBS | 1 | 24 | 8 | -40°C to +85°C | No |
| ADS12911PBS | QFN | RSM | 1 | 24 | 8 | -40°C to +85°C | No |
| A D C 4 200 I D D C | TQFP | PBS | 2 | 24 | 8 | -40°C to +85°C | No |
| ADS1292IPBS | QFN | RSM | 2 | 24 | 8 | -40°C to +85°C | No |
| ADS4202DIDDS | TQFP | PBS | 2 | 24 | 8 | -40°C to +85°C | Yes |
| ADS1292RIPBS | QFN | RSM | 2 | 24 | 8 | −40°C to +85°C | Yes |

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at www.ti.com.

ABSOLUTE MAXIMUM RATINGS(1)

Over operating free-air temperature range, unless otherwise noted.

| | | VALUE | UNIT |
|--------------------------------|---|--------------------------|------|
| AVDD to AVSS | | -0.3 to +7 | V |
| DVDD to DGND | | -0.3 to +7 | V |
| AVSS to DGND | | −3 to +0.2 | V |
| Analog input to AVSS | | AVSS - 0.3 to AVDD + 0.3 | V |
| Digital input to DVDD | | DVSS - 0.3 to DVDD + 0.3 | V |
| Input current to any pin excep | t supply pins ⁽²⁾ | ±10 | mA |
| Land account | Momentary | ±100 | mA |
| Input current | Continuous | ±10 | mA |
| Operating temperature range | Industrial-grade devices only | -40 to +85 | °C |
| Storage temperature range | | -60 to +150 | °C |
| Maximum junction temperatur | e (T _J) | +150 | °C |
| Electrostatic discharge | Human body model (HBM) JEDEC standard 22, test method A114-C.01, all pins | ±1000 | V |
| (ESD) ratings | Charged device model (CDM) JEDEC standard 22, test method C101, all pins | ±500 | V |

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

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⁽²⁾ Input terminals are diode-clamped to the power-supply rails. Input signals that can swing beyond the supply rails must be current limited to 10 mA or less.



ELECTRICAL CHARACTERISTICS

Minimum and maximum specifications apply from -40° C to $+85^{\circ}$ C. Typical specifications are at $+25^{\circ}$ C. All specifications at DVDD = 1.8 V, AVDD - AVSS = 3 V⁽¹⁾, V_{REF} = 2.42 V, external f_{CLK} = 512 kHz, data rate = 500 SPS, C_{FILTER} = 4.7 nF⁽²⁾, and gain = 6, unless otherwise noted.

| | | | ADS1191, ADS1192 | | | |
|--------|---|---|---|------|--------------|--|
| | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT | |
| ANALO | G INPUTS | | | | | |
| | Full-scale differential input voltage (AINP – AINN) | | ±V _{REF} /GAIN | | ٧ | |
| | Input common-mode range | | See the Input Common-Mode Ra subsection of the PGA Settings a Input Range section | | | |
| | Input capacitance | | 20 | | pF | |
| | | Input = 1.5 V | | ±1 | nA | |
| | Input bias current | Input = 1.5 V, T _A = -40°C to +85°C | ±2 | | nA | |
| | | No lead-off | 1000 | | ΜΩ | |
| | DC input impedance | Current source lead-off detection (nA range), AVSS + 0.3 V < AIN < AVDD - 0.3 V | 500 | | МΩ | |
| | | Current source lead-off detection (μA range), AVSS + 0.6 V < AIN < AVDD – 0.6 V | 100 | | МΩ | |
| PGA PE | RFORMANCE | | | | | |
| | Gain settings | | 1, 2, 3, 4, 6, 8, 12 | | | |
| BW | Bandwidth | With a 4.7-nF capacitor on PGA output (see <i>PGA Settings and Input Range</i> section for details) | 8.5 | | kHz | |
| ADC PE | RFORMANCE | | | | | |
| | Resolution | | 16 | | Bits | |
| DR | Data rate | | 125 | 8000 | SPS | |
| CHANN | EL PERFORMANCE (DC Performance) | | | | | |
| | | Gain = 6 ⁽³⁾ , 10 seconds of data | 24.6 | | μV_{PP} | |
| | Input-referred noise | Gain = 6, 256 points, 0.5 seconds of data | 24.6 | 25 | μV_{PP} | |
| | пристетей поізе | Gain settings other than 6, data rate other than 500 SPS | See Noise Measurements section | on | | |
| INL | Integral nonlinearity | Full-scale with gain = 6, best fit | ±1 | | LSB | |
| | Input-referred offset error | | ±100 | | μV | |
| | Input-referred offset error drift | | 2 | | μV/°C | |
| | Offset error with calibration | | 15 | | μV | |
| | Gain error | Excluding voltage reference error | ±0.5 | | % of F | |
| | Gain drift | Excluding voltage reference drift | 5 | | ppm/° | |
| | Gain match between channels | | 1 | | % of F | |
| CHANN | EL PERFORMANCE (AC performance) | | | | | |
| CMRR | Common-mode rejection ratio | f _{CM} = 50 Hz, 60 Hz ⁽⁴⁾ | -95 | | dB | |
| PSRR | Power-supply rejection ratio | f _{PS} = 50 Hz, 60 Hz | 90 | | dB | |
| | Crosstalk | f _{IN} = 50 Hz, 60 Hz | -120 | | dB | |
| | | | | | | |
| SNR | Signal-to-noise ratio | f _{IN} = 10 Hz input, gain = 6 | 92 | | dB | |

- 1) Performance is applicable for 5-V operation as well. Production testing for limits is performed at 3 V.
- (2) C_{FILTER} is the capacitor accross the PGA outputs; see the PGA Settings and Input Range section for details.

⁽³⁾ Noise data measured in a 10-second interval. Test not performed in production. Input-referred noise is calculated with input shorted (without electrode resistance) over a 10-second interval.

⁽⁴⁾ CMRR is measured with a common-mode signal of AVSS + 0.3 V to AVDD – 0.3 V. The values indicated are the minimum of the eight channels.



ELECTRICAL CHARACTERISTICS (continued)

Minimum and maximum specifications apply from -40° C to $+85^{\circ}$ C. Typical specifications are at $+25^{\circ}$ C. All specifications at DVDD = 1.8 V, AVDD - AVSS = 3 V⁽¹⁾, V_{REF} = 2.42 V, external f_{CLK} = 512 kHz, data rate = 500 SPS, C_{FILTER} = 4.7 nF⁽²⁾, and gain = 6, unless otherwise noted.

| | | | ADS11 | 91, ADS11 | 92 | |
|---------|--|---|------------|-----------------------|------------|---------------|
| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| RIGHT L | EG DRIVE (RLD) AMPLIFIER | | | | <u>"</u> | |
| | Integrated noise | BW = 150 Hz | | 1.4 | | μV_{RMS} |
| GBP | Gain bandwidth product | 50 kΩ 10 pF load, gain = 1 | | 100 | | kHz |
| SR | Slew rate | 50 kΩ 10 pF load, gain = 1 | | 0.07 | | V/µs |
| THD | Total harmonic distortion | f _{IN} = 100 Hz, gain = 1 | | -85 | | dB |
| CMIR | Common-mode input range | | AVSS + 0.3 | | AVDD - 0.3 | V |
| | Common-mode resistor matching | Internal 200-kΩ resistor matching | | 0.1 | | % |
| sc | Short-circuit current | | | 1.1 | | mA |
| | Quiescent power consumption | RLD amplifier | | 5 | | μA |
| LEAD-O | FF DETECT | | | | ' | |
| | Frequency | See Register Map section for settings | (| 0, f _{DR} /4 | | kHz |
| | | ILEAD_OFF [1:0] = 00 | | 6 | | nA |
| | 0 | ILEAD_OFF [1:0] = 01 | | 22 | | nA |
| | Current | ILEAD_OFF [1:0] = 10 | | 6 | | μA |
| | | ILEAD_OFF [1:0] = 11 | | 22 | | μA |
| | Current accuracy | | | ±20 | | % |
| | Comparator threshold accuracy | | | ±30 | | mV |
| EXTERN | IAL REFERENCE | | | | · | |
| | B. () , , , , , , , , , , , , , , , , , , | AVDD = 3 V, V _{REF} = (VREFP - VREFN) | 2 | 2.5 | VDD - 0.3 | V |
| | Reference input voltage | AVDD = 5 V, V _{REF} = (VREFP - VREFN) | 2 | 4 | VDD - 0.3 | V |
| VREFN | Negative input | | | AVSS | | V |
| VREFP | Positive input | | A\ | /SS + 2.5 | | V |
| | Input impedance | | | 120 | | kΩ |
| NTERN | AL REFERENCE | | | | ' | |
| | 0 | CONFIG2.VREF_4V = 0 | | 2.42 | | V |
| | Output voltage | CONFIG2.VREF_4V = 1 | | 4.033 | | V |
| | Output current drive | Available for external use | | 100 | | μA |
| | V _{REF} accuracy | | | ±0.5 | | % |
| | Internal reference drift | | | 45 | | ppm/°C |
| | Start-up time | Settled to 0.2% with 10-µF capacitor on VREFP pin | | 100 | | ms |
| | Quiescent current consumption | | | 20 | | μA |



ELECTRICAL CHARACTERISTICS (continued)

Minimum and maximum specifications apply from -40° C to $+85^{\circ}$ C. Typical specifications are at $+25^{\circ}$ C. All specifications at DVDD = 1.8 V, AVDD - AVSS = 3 V⁽¹⁾, V_{REF} = 2.42 V, external f_{CLK} = 512 kHz, data rate = 500 SPS, C_{FILTER} = 4.7 nF⁽²⁾, and gain = 6, unless otherwise noted.

| | | | | ADS1 | 191, ADS1192 | | |
|--------|-------------------------------------|---|---|------------|--------------|-----------|-------|
| | PARAMETER | र | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| SYSTEM | I MONITORS | | | | | | |
| | Analog supply reading | g error | | | 2 | | % |
| | Digital supply reading | error | | | 2 | | % |
| | | | From power supply ramp after power-on-reset to DRDY low | | 32 | | ms |
| | Device wake up | | From power-down mode to DRDY low | | 10 | | ms |
| | | | From STANDBY mode to DRDY low | | 10 | | ms |
| | VCAP1 settling time | | 1% accuracy with 1-µF capacitor | | 0.5 | | S |
| | Temperature sensor | Voltage | T _A = +25°C | | 145 | | mV |
| | reading Coefficient | | | | 490 | | μV/°C |
| EST SI | GNAL | | | | | | |
| | Signal frequency | | See Register Map section for settings | At c | dc and 1 Hz | | Hz |
| | Signal voltage | | See Register Map section for settings | | ±1 | | mV |
| | Accuracy | | | | ±2 | | % |
| CLOCK | | | | | | | |
| | | | Nominal frequency | | 512 | | kHz |
| | Internal oscillator clock frequency | | T _A = +25°C | | | ±0.5 | % |
| | | | -40°C ≤ T _A ≤ +85°C | | | ±1.5 | % |
| | Internal oscillator start-up time | | | | 32 | | μs |
| | Internal oscillator pow | ver consumption | | | 30 | | μW |
| | Future I alsolution at 6 | | CLKSEL pin = 0, CLK_DIV = 0 | 485 | 512 | 562.5 | kHz |
| | External clock input fr | requency | CLKSEL pin = 0, CLK_DIV = 1 | 1.94 | 2.048 | 2.25 | MHz |
| IGITAL | . INPUT/OUTPUT (DVD | D = 1.8 V to 3.6 V) | | | | | |
| | | V _{IH} (DVDD = 1.8 V to 3.6 V) | | 0.8 DVDD | D\ | VDD + 0.1 | V |
| | | V _{IL} (DVDD = 1.8 V to 3.6 V) | | -0.1 | (| 0.2 DVDD | V |
| | Logic level | V _{IH} (DVDD = 1.7 V to 1.8 V) | | DVDD - 0.2 | | | V |
| | | V _{IL} (DVDD = 1.7 V to 1.8 V) | | | | 0.2 | V |
| | | Input current (I _{IN}) | 0 V < V _{DigitalInput} < DVDD | -10 | | +10 | μΑ |
| OWER- | SUPPLY REQUIREME | NTS (RLD Amplifie | rs Turned Off) | | | | |
| AVDD | Analog supply | AVDD – AVSS | | 2.7 | 3 | 5.25 | V |
| VDD | Digital supply | | | 1.7 | 1.8 | 3.6 | V |
| | AVDD – DVDD | | | -2.1 | | 3.6 | V |
| SUPPLY | CURRENT | | | | | | |
| | | ADC1102 | AVDD – AVSS = 3 V | | 205 | | μΑ |
| | l _{AVDD} | ADS1192 | AVDD – AVSS = 5 V | | 250 | | μA |
| | | ADC4400 | DVDD = 3.3 V | | 75 | | μΑ |
| | I _{DVDD} | ADS1192 | DVDD = 1.8 V | | 32 | | μΑ |



ELECTRICAL CHARACTERISTICS (continued)

Minimum and maximum specifications apply from -40° C to $+85^{\circ}$ C. Typical specifications are at $+25^{\circ}$ C. All specifications at DVDD = 1.8 V, AVDD - AVSS = 3 V⁽¹⁾, V_{REF} = 2.42 V, external f_{CLK} = 512 kHz, data rate = 500 SPS, C_{FILTER} = 4.7 nF⁽²⁾, and gain = 6, unless otherwise noted.

| | | | ADS11 | 91, ADS1192 | | | |
|-----------------------------|-------------------|-----------------|-------|-------------|------|------|--|
| PARAMETEI | ₹ | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
| OWER DISSIPATION (Analog | Supply = 3 V, RLI | D Turned Off) | | | | | |
| | ADS1192 | Normal mode | | 670 | 740 | μW | |
| Quiescent power | | Standby mode | | 160 | | μW | |
| dissipation | ADS1191 | Normal mode | | 450 | 495 | μW | |
| | ADSTI91 | Standby mode | | 160 | | μW | |
| Quiescent power | ADS1192 | Normal mode | | 350 | | μW | |
| dissipation, per channel | ADS1191 | Normal mode | | 400 | | μW | |
| OWER DISSIPATION (Analog | Supply = 5 V, RLI | D Turned Off) | 1 | | | | |
| | ADS1192 | Normal mode | | 1300 | | μW | |
| Quiescent power | AD31192 | Standby mode | | 340 | | μW | |
| dissipation | ADS1191 | Normal mode | | 950 | | μW | |
| | | Standby mode | | 340 | | μW | |
| Quiescent power | ADS1192 | Normal mode | | 670 | | μW | |
| dissipation, per channel | ADS1191 | Normal mode | | 860 | | μW | |
| OWER DISSIPATION IN POW | ER-DOWN MODE | | | | " | | |
| A | DVDD = 1.8 V | | | 1 | | μW | |
| Analog supply = 3 V | DVDD = 3.3 V | | | 4 | | μW | |
| A1 5.V | DVDD = 1.8 V | | | 5 | | μW | |
| Analog supply = 5 V | DVDD = 3.3 V | | | 10 | | μW | |
| EMPERATURE | | | | | | | |
| Specified temperature | e range | | -40 | | +85 | °C | |
| Operating temperatur | re range | | -40 | | +85 | °C | |
| Storage temperature | range | | -60 | | +150 | °C | |

THERMAL INFORMATION

| | | ADS1191, | ADS1191, ADS1192 | | | |
|-------------------------|--|------------|------------------|-------|--|--|
| | THERMAL METRIC ⁽¹⁾ | PBS (TQFP) | RSM (QFN) | UNITS | | |
| | | 32 PINS | 32 PINS | | | |
| θ_{JA} | Junction-to-ambient thermal resistance | 68.4 | 33.7 | | | |
| θ_{JCtop} | Junction-to-case (top) thermal resistance | 25.9 | 36.4 | | | |
| θ_{JB} | Junction-to-board thermal resistance | 30.5 | 25.2 | 0000 | | |
| ΨЈТ | Junction-to-top characterization parameter | 0.5 | 0.2 | °C/W | | |
| ΨЈВ | Junction-to-board characterization parameter | 24.3 | 7.4 | | | |
| θ_{JCbot} | Junction-to-case (bottom) thermal resistance | N/A | 2.2 | | | |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



PARAMETER MEASUREMENT INFORMATION

NOISE MEASUREMENTS

The ADS1191/2 noise performance can be optimized by adjusting the data rate and PGA setting. As the averaging is increased by reducing the data rate, the noise drops correspondingly. Increasing the PGA value reduces the input-referred noise, which is particularly useful when measuring low-level biopotential signals. Table 1 and Table 2 summarize the noise performance of the ADS1191/2. The data are representative of typical noise performance at $T_A = +25^{\circ}$ C. The data shown are the result of averaging the readings from multiple devices and are measured with the inputs shorted together.

Table 1 and Table 2 show measurements taken with an internal reference. The data are also representative of the ADS1191/2 noise performance when using a low-noise external reference such as the REF5025.

Table 1. Input-Referred Noise (μV_{PP}) 3-V Analog Supply and 2.42-V Reference⁽¹⁾

| | | | PGA GAIN | | | | | | |
|-----------------------|---------------------|-----------------|--------------|------------------|------------------|------------------|------------------|------------------|------------------|
| DR BITS OF CONFIG1 | OUTPUT DATA RATE | –3-dB BANDWIDTH | x1 | x2 | х3 | x4 | х6 | x8 | x12 |
| REGISTER | (SPS) | (Hz) | μV_{PP} | μV _{PP} |
| 000 | 125 | 32.75 | 147.1 | 73.9 | 49.2 | 36.9 | 24.6 | 18.5 | 12.3 |
| 001 | 250 | 65.5 | 147.7 | 73.9 | 49.2 | 36.9 | 24.6 | 18.5 | 12.3 |
| 010 | 500 | 131 | 147.7 | 73.9 | 49.2 | 36.9 | 24.6 | 18.5 | 12.3 |
| 011 | 1000 | 262 | 147.7 | 73.9 | 49.2 | 36.9 | 24.6 | 18.5 | 12.3 |
| 100 | 2000 | 524 | 221.5 | 110.8 | 73.8 | 55.4 | 36.9 | 27.7 | 18.5 |
| 101 | 4000 | 1048 | 810.0 | 405.0 | 270.0 | 202.5 | 135.0 | 101.3 | 67.5 |
| 110 | 8000 | 2096 | 3900.0 | 1950.0 | 1300.0 | 975.0 | 650.0 | 487.5 | 325.0 |

⁽¹⁾ At least 1000 consecutive readings were used to calculate the peak-to-peak noise values in this table.

Table 2. Input-Referred Noise (μV_{PP}) 5-V Analog Supply and 4.033-V Reference⁽¹⁾

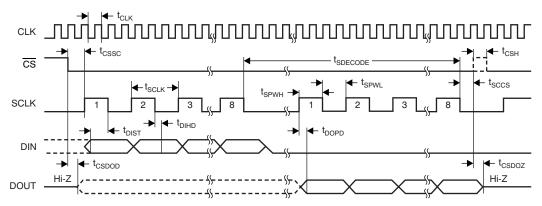
| | | | | | | PGA GAIN | | | |
|-----------------------|---------------------|-----------------|--------------|------------------|------------------|------------------|------------------|------------------|------------------|
| DR BITS OF CONFIG1 | OUTPUT DATA RATE | –3-dB BANDWIDTH | x1 | x2 | х3 | x4 | х6 | х8 | x12 |
| REGISTER | (SPS) | (Hz) | μV_{PP} | μV _{PP} |
| 000 | 125 | 32.75 | 246.1 | 123.1 | 82.0 | 61.5 | 41.0 | 30.8 | 20.5 |
| 001 | 250 | 65.5 | 246.1 | 123.1 | 82.0 | 61.5 | 41.0 | 30.8 | 20.5 |
| 010 | 500 | 131 | 246.1 | 123.1 | 82.0 | 61.5 | 41.0 | 30.8 | 20.5 |
| 011 | 1000 | 262 | 246.1 | 123.1 | 82.0 | 61.5 | 41.0 | 30.8 | 20.5 |
| 100 | 2000 | 524 | 369.2 | 184.6 | 123.1 | 92.3 | 61.5 | 46.2 | 30.8 |
| 101 | 4000 | 1048 | 1230.0 | 615.0 | 410.0 | 307.5 | 205.0 | 153.8 | 102.5 |
| 110 | 8000 | 2096 | 6800.0 | 3400.0 | 2266.7 | 1700.0 | 1133.3 | 850.0 | 566.7 |

⁽¹⁾ At least 1000 consecutive readings were used to calculate the peak-to-peak noise values in this table.

Product Folder Links: ADS1191 ADS1192



TIMING CHARACTERISTICS



NOTE: SPI settings are CPOL = 0 and CPHA = 1.

Figure 1. Serial Interface Timing

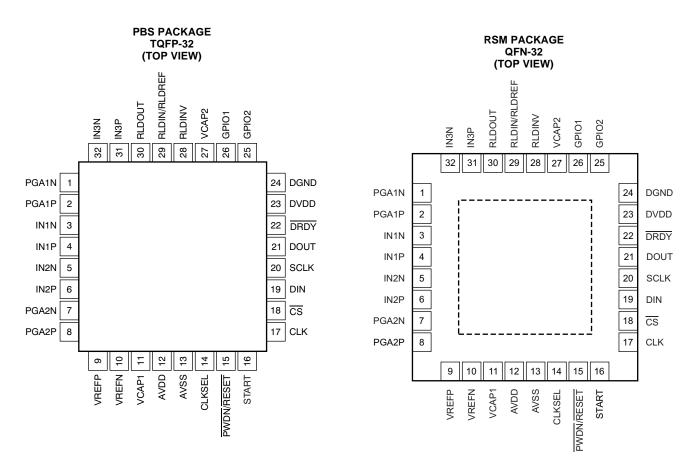
Timing Requirements For Figure 1⁽¹⁾

| | | 2.7 V ≤ DVDD ≤ 3.6 V | | | DVDD ≤ 2 | .7 V | |
|----------------------|---|----------------------|---------|------|----------|------|-------------------|
| PARAMETER | DESCRIPTION | MIN | TYP MAX | MIN | TYP | MAX | UNIT |
| | Master clock period (CLK_DIV bit of LOFF_STAT register = 0) | TBD | TBD | TBD | | TBD | ns |
| t _{CLK} | Master clock period (CLK_DIV bit of LOFF_STAT register = 1) | 414 | 514 | 514 | | 465 | ns |
| t _{CSSC} | CS low to first SCLK, setup time | 6 | | 17 | | | ns |
| t _{SCLK} | SCLK period | 50 | | 66.6 | | | ns |
| t _{SPWH, L} | SCLK pulse width, high and low | 15 | | 25 | | | ns |
| t _{DIST} | DIN valid to SCLK falling edge: setup time | 10 | | 10 | | | ns |
| t _{DIHD} | Valid DIN after SCLK falling edge: hold time | 10 | | 11 | | | ns |
| t _{DOPD} | SCLK rising edge to DOUT valid: setup time | | 12 | | | 22 | ns |
| t _{CSH} | CS high pulse | 2 | | 2 | | | t _{CLKs} |
| t _{CSDOD} | CS low to DOUT driven | 10 | | 20 | | | ns |
| t _{SCCS} | Eighth SCLK falling edge to CS high | 4 | | 4 | | | t _{CLKs} |
| t _{SDECODE} | Command decode time | 4 | | 4 | | | t _{CLKs} |
| t _{CSDOZ} | CS high to DOUT Hi-Z | | 10 | | | 20 | ns |

⁽¹⁾ Specified at $T_A = -40^{\circ}C$ to +85°C, unless otherwise noted. Load on $D_{OUT} = 20$ pF || 100 k Ω .



PIN CONFIGURATIONS





PIN ASSIGNMENTS

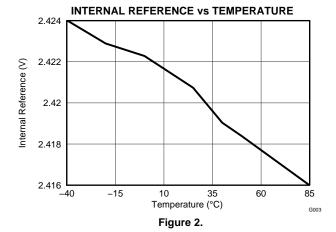
| NAME | TERMINAL | FUNCTION | DESCRIPTION |
|---------------------|----------|----------------------|--|
| AVDD | 12 | Supply | Analog supply |
| AVSS | 13 | Supply | Analog ground |
| CS | 18 | Digital input | Chip select |
| CLK | 17 | Digital input | Master clock input |
| CLKSEL | 14 | Digital input | Master clock select |
| DGND | 24 | | Digital ground |
| DIN | 19 | Supply | SPI data in |
| | | Digital input | |
| DOUT | 21 | Digital output | SPI data out |
| DRDY | 22 | Digital output | Data ready; active low |
| DVDD | 23 | Supply | Digital power supply |
| GPIO1/RCLK1 | 26 | Digital input/output | GPIO1 |
| GPIO2/RCLK2 | 25 | Digital input/output | GPIO2 |
| IN1N ⁽¹⁾ | 3 | Analog input | Differential analog negative input 1 |
| IN1P ⁽¹⁾ | 4 | Analog input | Differential analog positive input 1 |
| IN2N ⁽¹⁾ | 5 | Analog input | Differential analog negative input 2 |
| IN2P ⁽¹⁾ | 6 | Analog input | Differential analog positive input 2 |
| PGA1N | 1 | Analog output | Differential analog negative output 1 |
| PGA1P | 2 | Analog output | Differential analog positive output 1 |
| PGA2N | 7 | Analog output | Differential analog negative output 2 |
| PGA2P | 8 | Analog output | Differential analog positive output 2 |
| PWDN/RESET | 15 | Digital input | Power-down/System reset; active low |
| RLDIN/RLDREF | 29 | Analog input | Right leg drive input to MUX/RLD reference |
| RLDINV | 28 | Analog input | Right leg drive inverting input |
| RLDOUT | 30 | Analog input | Right leg drive output |
| IN3N ⁽¹⁾ | 32 | Analog input/output | Differential analog negative input 3 |
| IN3P ⁽¹⁾ | 31 | Analog input/output | Differential analog positive input 3 |
| SCLK | 20 | Digital input | SPI clock |
| START | 16 | Digital input | Start conversion |
| VCAP1 | 11 | _ | Analog bypass capacitor |
| VCAP2 | 27 | _ | Analog bypass capacitor |
| VREFN | 10 | Analog input | Negative reference voltage |
| VREFP | 9 | Analog input/output | Positive reference voltage |

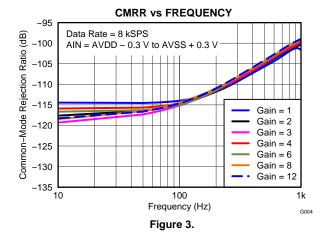
⁽¹⁾ Excludes effects of noise, linearity, offset, and gain error.

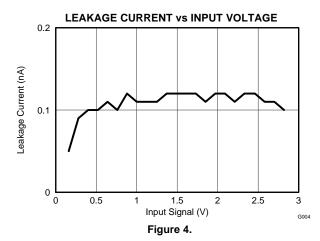


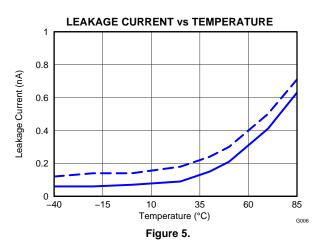
TYPICAL CHARACTERISTICS

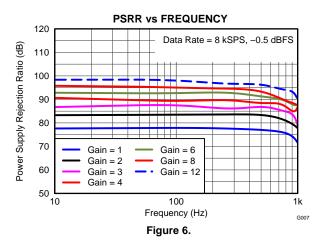
All plots at $T_A = +25$ °C, AVDD = 3 V, AVSS = 0 V, DVDD = 1.8 V, internal VREFP = 2.42 V, VREFN = AVSS, external clock = 512 kHz, data rate = 500 SPS, and gain = 6, unless otherwise noted.

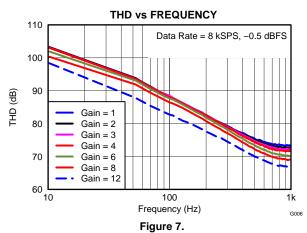










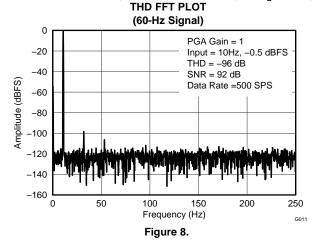


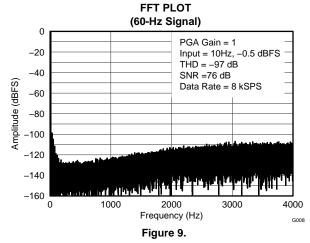


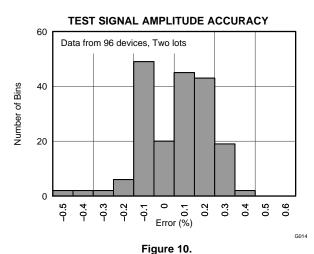
TYPICAL CHARACTERISTICS (continued)

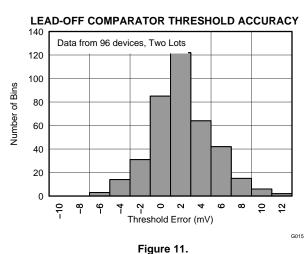
All plots at T_A = +25°C, AVDD = 3 V, AVSS = 0 V, DVDD = 1.8 V, internal VREFP = 2.42 V, VREFN = AVSS,

external clock = 512 kHz, data rate = 500 SPS, and gain = 6, unless otherwise noted. THD FFT PLOT









LEAD-OFF CURRENT SOURCE ACCURACY DISTRIBUTION

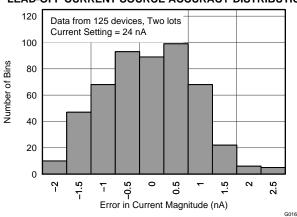


Figure 12.

12

Product Folder Links: ADS1191 ADS1192



OVERVIEW

The ADS1191/2 are low-power, multichannel, simultaneously-sampling, 16-bit delta-sigma ($\Delta\Sigma$) analog-to-digital converters (ADCs) with integrated programmable gain amplifiers (PGAs). These devices integrate various ECG-specific functions that make them well-suited for scalable electrocardiogram (ECG), sports, and fitness applications. The devices can also be used in high-performance, multichannel data acquisition systems by powering down the ECG-specific circuitry.

The ADS1191/2 have a highly programmable multiplexer that allows for temperature, supply, input short, and RLD measurements. Additionally, the multiplexer allows any of the input electrodes to be programmed as the patient reference drive. The PGA gain can be chosen from one of seven settings (1, 2, 3, 4, 6, 8, and 12). The ADCs in the device offer data rates from 125 SPS to 8 kSPS. Communication to the device is accomplished using an SPI-compatible interface. The device provides two general-purpose I/O (GPIO) pins for general use. Multiple devices can be synchronized using the START pin.

The internal reference can be programmed to either 2.42 V or 4.033 V. The internal oscillator generates a 512-kHz clock. The versatile right leg drive (RLD) block allows the user to choose the average of any combination of electrodes to generate the patient drive signal. Lead-off detection can be accomplished either by using an external pull-up/pull-down resistor or the device internal current source/sink. An internal ac lead-off detection feature is also available. A detailed diagram of the ADS1191/2 is shown in Figure 13.

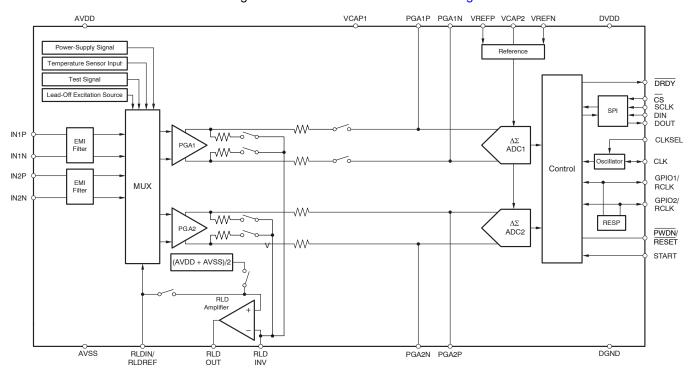


Figure 13. Functional Block Diagram



THEORY OF OPERATION

This section contains details of the ADS1191/2 internal functional elements. The analog blocks are discussed first followed by the digital interface. Blocks implementing ECG-specific functions are covered in the end.

Throughout this document, f_{CLK} denotes the frequency of the signal at the CLK pin, t_{CLK} denotes the period of the signal at the CLK pin, f_{DR} denotes the output data rate, t_{DR} denotes the time period of the output data, and f_{MOD} denotes the frequency at which the modulator samples the input.

EMI FILTER

An RC filter at the input acts as an EMI filter on channels 1 and 2. The -3-dB filter bandwidth is approximately 3 MHz.

INPUT MULTIPLEXER

The ADS1191/2 input multiplexers are very flexible and provide many configurable signal switching options. Refer to Figure 14 for a diagram of the ADS1191/2 multiplexer. Note that IN3P, IN3N, and RLDIN are common to both channels. VINP and VINN are separate for each of the three pins. This flexibility allows for significant device and sub-system diagnostics, calibration, and configuration. Selection of switch settings for each channel is made by writing the appropriate values to the CH1SET or CH2SET register (see the CH1SET and CH2SET Registers in the Register Map section for details.) More details of the ECG-specific features of the multiplexer are discussed in the Input Multiplexer subsection of the ECG-Specific Functions.

Device Noise Measurements

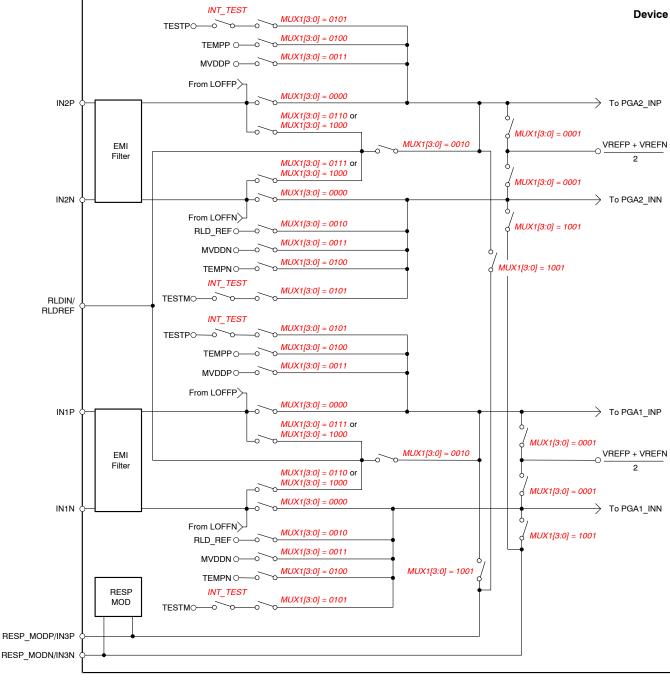
Setting CHnSET[3:0] = 0001 sets the common-mode voltage of (VREFP + VREFN)/2 to both inputs of the channel. This setting can be used to test the inherent noise of the device in the user system.

Test Signals (TestP and TestN)

Setting CHnSET[2:0] = 101 provides internally-generated test signals for use in sub-system verification at power-up. This functionality allows the entire signal chain to be tested out. Although the test signals are similar to the CAL signals described in the IEC60601-2-51 specification, this feature is not intended for use in compliance testing.

Control of the test signals is accomplished through register settings (see the CONFIG2: Configuration Register 2 subsection in the Register Map section for details). TEST_AMP controls the signal amplitude and TEST_FREQ controls switching at the required frequency.





NOTE: MVDD monitor voltage supply depends on channel number; see the Supply Measurements (MVDDP, MVDDN) section.

Figure 14. Input Multiplexer Block for Both Channels



Auxiliary Differential Input (IN3N, IN3P)

The IN3N and IN3P signals can be used as a third multiplexed differential input channel. These inputs can be multiplexed to either of the ADC channels.

Temperature Sensor (TempP, TempN)

The ADS1191/2 contain an on-chip temperature sensor. This sensor uses two internal diodes with one diode having a current density 16x that of the other, as shown in Figure 15. The difference in current densities of the diodes yields a difference in voltage that is proportional to absolute temperature.

As a result of the low thermal resistance of the package to the printed circuit board (PCB), the internal device temperature tracks the PCB temperature closely. Note that self-heating of the ADS1191/2 causes a higher reading than the temperature of the surrounding PCB.

The scale factor of Equation 1 converts the temperature reading to $^{\circ}$ C. Before using this equation, the temperature reading code must first be scaled to μ V.

Figure 15. Measurement of the Temperature Sensor in the Input

Supply Measurements (MVDDP, MVDDN)

Setting CHnSET[2:0] = 011 sets the channel inputs to different supply voltages of the device. For channel 1 (MVDDP – MVDDN) is [0.5(AVDD + AVSS)]; for channel 2 (MVDDP – MVDDN) is DVDD/4. Note that to avoid saturating the PGA while measuring power supplies, the gain must be set to '1'.

Lead-Off Excitation Signals (LoffP, LoffN)

The lead-off excitation signals are fed into the multiplexer before the switches. The comparators that detect the lead-off condition are also connected to the multiplexer block before the switches. For a detailed description of the lead-off block, refer to the *Lead-Off Detection* subsection in the *ECG-Specific Functions* section.

Auxiliary Single-Ended Input

The RLDIN pin is primarily used for routing the right leg drive signal to any of the electrodes in case the right leg drive electrode falls off. However, the RLDIN pin can be used as a multiple single-ended input channel. The signal at the RLDIN pin can be measured with respect to the voltage at the RLD_REF pin using either channel. This measurement is done by setting the channel multiplexer setting MUXn[3:0] to '0010' in the CH1SET and CH2SET registers.



ANALOG INPUT

The analog input to the ADS1191/2 is fully differential. Assuming PGA = 1, the differential input (INP – INN) can span between $-V_{REF}$ to $+V_{REF}$. Refer to Table 4 for an explanation of the correlation between the analog input and the digital codes. There are two general methods of driving the analog input of the ADS1191/2: single-ended or differential, as shown in Figure 16 and Figure 17. Note that INP and INN are 180°C out-of-phase in the differential input method. When the input is single-ended, the INN input is held at the common-mode voltage, preferably at mid-supply. The INP input swings around the same common voltage and the peak-to-peak amplitude is the (common-mode + 1/2 V_{REF}) and the (common-mode – 1/2 V_{REF}). When the input is differential, the common-mode is given by (INP + INN)/2. Both the INP and INN inputs swing from (common-mode + 1/2 V_{REF}) to common-mode – 1/2 V_{REF}). For optimal performance, it is recommended that the ADS1191/2 be used in a differential configuration.

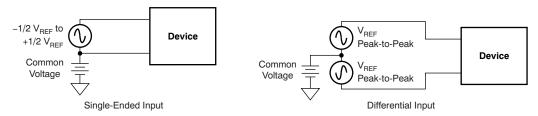


Figure 16. Methods of Driving the ADS1191/2: Single-Ended or Differential

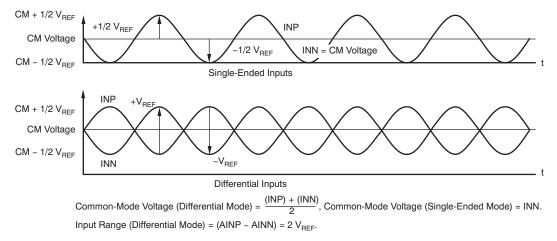


Figure 17. Using the ADS1191/2 in the Single-Ended and Differential Input Modes



PGA SETTINGS AND INPUT RANGE

The PGA is a differential input/differential output amplifier, as shown in Figure 18. It has seven gain settings (1, 2, 3, 4, 6, 8, and 12) that can be set by writing to the CHnSET register (see the CH1SET and CH2SET Registers in the Register Map section for details). The ADS1191/2 have CMOS inputs and hence have negligible current noise.

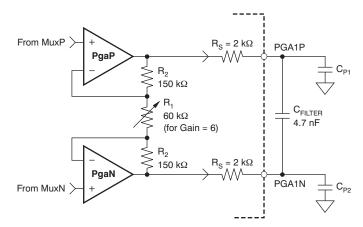


Figure 18. PGA Implementation

The resistor string of the PGA that implements the gain has 360 k Ω of resistance for a gain of 6. This resistance provides a current path across the outputs of the PGA in the presence of a differential input signal. This current is in addition to the quiescent current specified for the device in the presence of a differential signal at the input. The output of PGA is filtered by an RC filter before it goes to the ADC. The filter is formed by an internal resistor R_S = 2 k Ω and an external capacitor C_{FILTER} (4.7 nF, typical). This filter acts as an anti-aliasing filter with the –3-dB bandwidth of 8.4 kHz. The internal R_S resistor is accurate to 15% so actual bandwidth will vary. This RC filter also suppresses the glitch at the output of PGA caused by ADC sampling. The minimum value of C_{EXT} that can be used is 4 nF. A larger value C_{FILTER} capacitor can be used for increased attenution at higher frequencies for anti-aliasing purposes. The tradeoff is that a larger capacitor value gives degraded THD performance. See Figure 19 for a plot showing the THD versus C_{FILTER} value.

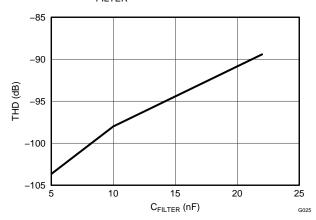


Figure 19. THD versus C_{FILTER} Value

Special care must be taken in PCB layout to minimize the parasitic capacitance C_{P1}/C_{P2} . The absolute value of these capacitances must be less than 20 pF. Ideally, C_{FILTER} should be placed right at the pins to minimize these capacitors. Mismatch between these capacitors will lead to CMRR degradation. Assuming everything else is perfectly matched, the 60 Hz CMRR as a function of this mismatch is given by Equation 2.

CMRR =
$$20\log \frac{\text{Gain}}{2\pi \times 2\text{e}3 \times \Delta C_{\text{P}} \times 60}$$
 (2)

where $\Delta C_P = C_{P1} - C_{P2}$



For example, a mismatch of 20 pF with a gain of 6 limits the CMRR to 112 dB. If ΔC_P is small, then the CMRR is limited by the PGA itself and is as specified in the Electrical Characteristics table. The PGA are chopped internally at either 8, 32, or 64 kSPS. The digital decimation filter filters out the chopping ripple in the normal path so the chopping ripple is not a concern. First-order filtering is provided by the RC filter at the PGA output. Additional filtering may be needed to suppress the chopping ripple. If the PGA output is routed to other circuitry, a 20-k Ω series resistance must be added in the path near the C_{FILTER} capacitor. The routing should be matched to maintain the CMRR performance.

Input Common-Mode Range

The usable input common-mode range of the front end depends on various parameters, including the maximum differential input signal, supply voltage, PGA gain, etc. This range is described in Equation 3:

$$\text{AVDD} - 0.4 - \left[\frac{\text{Gain V}_{\text{MAX_DIFF}}}{2}\right] > \text{CM} > \text{AVSS} + 0.4 + \left[\frac{\text{Gain V}_{\text{MAX_DIFF}}}{2}\right]$$

where:

V_{MAX DIFF} = maximum differential signal at the input of the PGA

For example:

If
$$V_{DD} = 3$$
 V, gain = 6, and $V_{MAX_DIFF} = 350$ mV Then 1.25 V < CM < 1.75 V

Input Differential Dynamic Range

The differential (INP – INN) signal range depends on the analog supply and reference used in the system. This range is shown in Equation 4.

$$\text{Max (INP - INN)} < \frac{V_{\text{REF}}}{\text{Gain}} \quad \text{Full-Scale Range} = \frac{\pm V_{\text{REF}}}{\text{Gain}} = \frac{2 V_{\text{REF}}}{\text{Gain}} \tag{4}$$

The 3-V supply, with a reference of 2.42 V and a gain of 6 for ECGs, is optimized for power with a differential input signal of approximately 300 mV. For higher dynamic range, a 5-V supply with a reference of 4 V (set by the VREF_4V bit of the CONFIG3 register) can be used to increase the differential dynamic range.

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ADC ΔΣ Modulator

Each channel of the ADS1191/2 has a 16-bit $\Delta\Sigma$ ADC. This converter uses a second-order modulator optimized for low-power applications. The modulator samples the input signal at the rate of $f_{MOD} = f_{CLK}/4$ or $f_{CLK}/16$, as determined by the CLK_DIV bit. In both cases, the sampling clock has a typical value of 128 kHz. As in the case of any $\Delta\Sigma$ modulator, the noise of the ADS1191/2 is shaped until $f_{MOD}/2$, as shown in Figure 20. The on-chip digital decimation filters explained in the next section can be used to filter out the noise at higher frequencies. These on-chip decimation filters also provide antialias filtering. This feature of the $\Delta\Sigma$ converters drastically reduces the complexity of the analog antialiasing filters that are typically needed with nyquist ADCs.

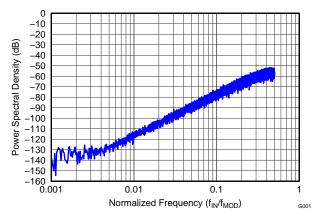


Figure 20. Power Spectral Density (PSD) of a ΔΣ Modulator (4-Bit Quantizer)

DIGITAL DECIMATION FILTER

The digital filter receives the modulator output and decimates the data stream. By adjusting the amount of filtering, tradeoffs can be made between resolution and data rate: filter more for higher resolution, filter less for higher data rates. Higher data rates are typically used in ECG applications for implement software pace detection and ac lead-off detection.

The digital filter on each channel consists of a third-order sinc filter. The decimation ratio on the sinc filters can be adjusted by the DR bits in the CONFIG1 register (see the *Register Map* section for details). This setting is a global setting that affects all channels and, therefore, in a device all channels operate at the same data rate.

Sinc Filter Stage (sinx/x)

The sinc filter is a variable decimation rate, third-order, low-pass filter. Data are supplied to this section of the filter from the modulator at the rate of f_{MOD} . The sinc filter attenuates the high-frequency noise of the modulator, then decimates the data stream into parallel data. The decimation rate affects the overall data rate of the converter.

Equation 5 shows the scaled Z-domain transfer function of the sinc filter.

$$|H(z)| = \left| \frac{1 - Z^{-N}}{1 - Z^{-1}} \right|^{3}$$
 (5)

The frequency domain transfer function of the sinc filter is shown in Equation 6.

$$H(f) \mid = \left| \frac{\sin\left(\frac{N\pi f}{f_{MOD}}\right)}{N \times \sin\left(\frac{\pi f}{f_{MOD}}\right)} \right|^{3}$$

where:

N = decimation ratio (6)



The sinc filter has notches (or zeroes) that occur at the output data rate and multiples thereof. At these frequencies, the filter has infinite attenuation. Figure 21 shows the frequency response of the sinc filter and Figure 22 shows the roll-off of the sinc filter. With a step change at input, the filter takes 3 t_{DR} to settle. After a rising edge of the START signal, the filter takes t_{SETTLE} time to give the first data output. The settling time of the filters at various data rates are discussed in the START subsection of the SPI Interface section. Figure 23 and Figure 24 show the filter transfer function until $t_{MOD}/2$ and $t_{MOD}/16$, respectively, at different data rates. Figure 25 shows the transfer function extended until 4 t_{MOD} . It can be seen that the passband of the ADS1191/2 repeats itself at every t_{MOD} . The input R-C anti-aliasing filters in the system should be chosen such that any interference in frequencies around multiples of t_{MOD} are attenuated sufficiently.

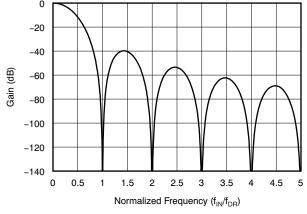
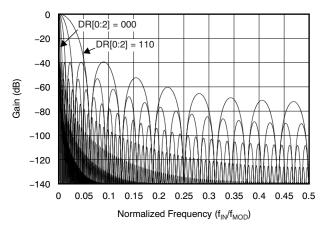


Figure 21. THD vs Frequency

Figure 22. INL vs PGA Gain



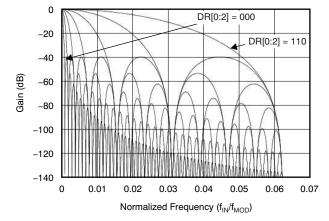


Figure 23. Transfer Function of On-Chip Decimation Filters Until f_{MOD}/2

Figure 24. Transfer Function of On-Chip Decimation Filters Until f_{MOD}/16

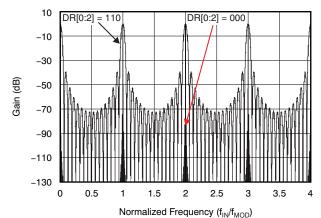
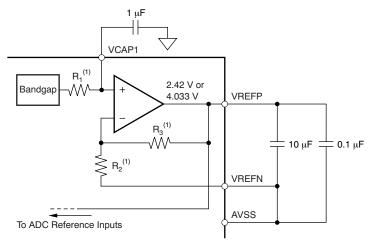


Figure 25. Transfer Function of On-Chip Decimation Filters Until $4f_{MOD}$ for DR[0:2] = 000 and DR[0:2] = 110

REFERENCE

Figure 26 shows a simplified block diagram of the internal reference of the ADS1191/2. The reference voltage is generated with respect to AVSS. The VREFN pin must always be connected to AVSS.



 $\text{(1) For V}_{REF} = 2.42 \text{ V: } R_1 = 100 \text{ k}\Omega, \ R_2 = 200 \text{ k}\Omega, \ \text{and} \ R_3 = 200 \text{ k}\Omega. \ \text{For V}_{REF} = 4.033 \text{ V: } R_1 = 84 \text{ k}\Omega, \ R_2 = 120 \text{ k}\Omega, \ \text{and} \ R_3 = 280 \text{ k}\Omega.$

Figure 26. Internal Reference

The external band-limiting capacitors determine the amount of reference noise contribution. For high-end ECG systems, the capacitor values should be chosen such that the bandwidth is limited to less than 10 Hz, so that the reference noise does not dominate the system noise. When using a 3-V analog supply, the internal reference must be set to 2.42 V. In case of a 5-V analog supply, the internal reference can be set to 4.033 V by setting the VREF_4V bit in the CONFIG2 register.

Alternatively, the internal reference buffer can be powered down and VREFP can be applied externally. Figure 27 shows a typical external reference drive circuitry. Power-down is controlled by the PD_REFBUF bit in the CONFIG3 register. This power-down is also used to share internal references when two devices are cascaded. By default, the device wakes up in external reference mode.



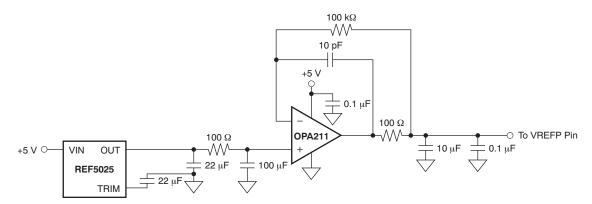


Figure 27. External Reference Driver



CLOCK

The ADS1191/2 provide two different methods for device clocking: internal and external. Internal clocking is ideally suited for low-power, battery-powered systems. The internal oscillator is trimmed for accuracy at room temperature. Over the specified temperature range the accuracy varies; see the Electrical Characteristics. Clock selection is controlled by the CLKSEL pin and the CLK_EN register bit.

The CLKSEL pin selects either the internal or external clock. The CLK_EN bit in the CONFIG1 register enables and disables the oscillator clock to be output in the CLK pin. A truth table for these two pins is shown in Table 3. The CLK_EN bit is useful when multiple devices are used in a daisy-chain configuration. It is recommended that during power-down the external clock be shut down to save power.

Table 3. CLKSEL Pin and CLK_EN Bit

| CLKSEL PIN | CONFIG1.CLK_EN BIT | CLOCK SOURCE | CLK PIN STATUS |
|------------|-----------------------|---------------------------|-----------------------------------|
| 0 | X | External clock | Input: external clock |
| 1 | 0 | Internal clock oscillator | 3-state |
| 1 | 1 | Internal clock oscillator | Output: internal clock oscillator |

The ADS1191/2 have the option to choose between two different external clock frequencies (512 kHz or 2.048 MHz). This frequency is selected by setting the CLK_DIV bit (bit 6) in the LOFF_STAT register. The modulator must be clocked at 128 kHz, regardless of the external clock frequency. Figure 28 shows the relationship between the external clock (f_{CLK}) and the modulator clock (f_{MOD}). The default mode of operation is f_{CLK} = 512 kHz. The higher frequency option has only been provided to allow the SPI to run at a higher speed. SCLK can be only twice the speed of f_{CLK} during a register read and/or write.

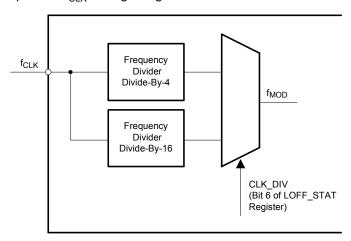


Figure 28. Relationship Between External Clock (f_{CLK}) and Modulator Clock (f_{MOD})



DATA FORMAT

The ADS1191/2 outputs 16 bits of data per channel in binary twos complement format, MSB first. The LSB has a weight of $V_{REF}/(2^{15}-1)$. A positive full-scale input produces an output code of 7FFFh and the negative full-scale input produces an output code of 8000h. The output clips at these codes for signals exceeding full-scale. Table 4 summarizes the ideal output codes for different input signals. All 16 bits toggle when the analog input is at positive or negative full-scale.

Table 4. Ideal Output Code versus Input Signal

| INPUT SIGNAL, V _{IN} (AINP – AINN) | IDEAL OUTPUT CODE(1) |
|--|----------------------|
| ≥ V _{REF} | 7FFFh |
| +V _{REF} /(2 ¹⁵ - 1) | 0001h |
| 0 | 0000h |
| -V _{REF} /(2 ¹⁵ - 1) | FFFFh |
| $\leq -V_{REF} (2^{15}/2^{15} - 1)$ | 8000h |

(1) Excludes effects of noise, linearity, offset, and gain error.

SPI INTERFACE

The SPI-compatible serial interface consists of four signals: \overline{CS} , SCLK, DIN, and DOUT. The interface reads conversion data, reads and writes registers, and controls the ADS1191/2 operation. The DRDY output is used as a status signal to indicate when data are ready. DRDY goes low when new data are available.

Chip Select (CS)

Chip select (\overline{CS}) selects the ADS1191/2 for SPI communication. \overline{CS} must remain low for the entire duration of the serial communication. After the serial communication is finished, always wait four or more t_{CLK} cycles before taking \overline{CS} high. When \overline{CS} is taken high, the serial interface is reset, SCLK and DIN are ignored, and \overline{DOUT} enters a high-impedance state. \overline{DRDY} asserts when data conversion is complete, regardless of whether \overline{CS} is high or low.

Serial Clock (SCLK)

SCLK is the serial peripheral interface (SPI) serial clock. It is used to shift in commands and shift out data from the device. The serial clock (SCLK) features a Schmitt-triggered input and clocks data on the DIN and DOUT pins into and out of the ADS1191/2. Even though the input has hysteresis, it is recommended to keep SCLK as clean as possible to prevent glitches from accidentally forcing a clock event. The absolute maximum limit for SCLK is specified in the Serial Interface Timing table. When shifting in commands with SCLK, make sure that the entire set of SCLKs is issued to the device. Failure to do so could result in the device serial interface being placed into an unknown state, requiring $\overline{\text{CS}}$ to be taken high to recover.

For a single device, the minimum speed needed for the SCLK depends on the number of channels, number of bits of resolution, and output data rate. (For multiple cascaded devices, see the *Cascade Mode* subsection of the *Multiple Device Configuration* section.)

$$t_{SCLK} < (t_{DR} - 4 t_{CLK})/(N_{BITS}N_{CHANNELS} + 24)$$

$$(7)$$

For example, if the ADS1191/2 is used in a 500-SPS mode (two channels, 16-bit resolution), the minimum SCLK speed is approximately 36 kHz.

Data retrieval can be done either by putting the device in RDATAC mode or by issuing a RDATA command for data on demand. The above SCLK rate limitation applies to RDATAC. For the RDATA command, the limitation applies if data must be read in between two consecutive \overline{DRDY} signals. The above calculation assumes that there are no other commands issued in between data captures. SCLK can only be twice the speed of f_{CLK} during register reads and writes. For faster SPI interface, use $f_{CLK} = 2.048$ MHz and set the CLK_DIV register bit (in the LOFF STAT register) to '1'.



Data Input (DIN)

The data input pin (DIN) is used along with SCLK to communicate with the ADS1191/2 (opcode commands and register data). The device latches data on DIN on the falling edge of SCLK.

Data Output (DOUT)

The data output pin (DOUT) is used with SCLK to read conversion and register data from the ADS1191/2. Data on DOUT are shifted out on the rising edge of SCLK. DOUT goes to a high-impedance state when \overline{CS} is high. In read data continuous mode (see the *SPI Command Definitions* section for more details), the DOUT output line also indicates when new data are available. This feature can be used to minimize the number of connections between the device and the system controller.

Figure 29 shows the data output protocol for ADS1192.

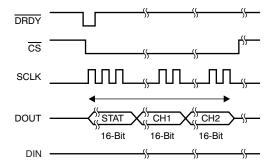


Figure 29. SPI Bus Data Output for the ADS1192 (Two Channels)

Data Retrieval

Data retrieval can be accomplished in one of two methods. The read data continuous command (see the RDATAC: Read Data Continuous section) can be used to set the device in a mode to read the data continuously without sending opcodes. The read data command (see the RDATA: Read Data section) can be used to read just one data output from the device (see the SPI Command Definitions section for more details). The conversion data are read by shifting the data out on DOUT. The MSB of the data on DOUT is clocked out on the first SCLK rising edge. DRDY returns to high on the first SCLK falling edge. DIN should remain low for the entire read operation.

The number of bits in the data output depends on the number of channels and the number of bits per channel. For the ADS1191/2, the number of data outputs is (16 status bits + 16 bits \times 2 channels) = 48 bits. The format of the 16 status bits is (1100 + LOFF_STAT[4:0] + GPIO[1:0] + 5 zeros). The data format for each channel data are twos complement and MSB first. When channels are powered down using the user register setting, the corresponding channel output is set to '0'. However, the sequence of channel outputs remains the same.

The ADS1191/2 also provide a multiple readback feature. The data can be read out multiple times by simply giving more SCLKs, in which case the MSB data byte repeats after reading the last byte.

Data Ready (DRDY)

DRDY is an output. When it transitions low, new conversion data are ready. The \overline{CS} signal has no effect on the data ready signal. The behavior of \overline{DRDY} is determined by whether the device is in RDATAC mode or the RDATA command is being used to read data on demand. (See the RDATAC: Read Data Continuous and RDATA: Read Data subsections of the SPI Command Definitions section for further details).

When reading data with the RDATA command, the read operation can overlap the occurrence of the next DRDY without data corruption.

The START pin or the START command is used to place the device either in normal data capture mode or pulse data capture mode.



Figure 30 shows the relationship between DRDY, DOUT, and SCLK during data retrieval (in case of an ADS1191/2 with a selected data rate that gives 16-bit resolution). DOUT is latched out at the rising edge of SCLK. DRDY is pulled high at the falling edge of SCLK. Note that DRDY goes high on the first falling edge SCLK regardless of the status of the CS signal and regardless of whether data are being retrieved from the device or a command is being sent through the DIN pin.

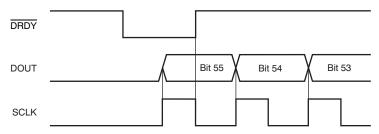


Figure 30. \overline{DRDY} with Data Retrieval ($\overline{CS} = 0$)

GPIO

The ADS1191/2 have a total of two general-purpose digital I/O (GPIO) pins available in the normal mode of operation. The digital I/O pins are individually configurable as either inputs or as outputs through the GPIOC bits register. The GPIOD bits in the GPIO register control the level of the pins. When reading the GPIOD bits, the data returned are the logic level of the pins, whether they are programmed as inputs or outputs. When the GPIO pin is configured as an input, a write to the corresponding GPIOD bit has no effect. When configured as an output, a write to the GPIOD bit sets the output value.

If configured as inputs, these pins must be driven (do not float). The GPIO pins are set as inputs after power-on or after a reset. Figure 31 shows the GPIO port structure. The pins should be shorted to DGND with a series resistor if not used.

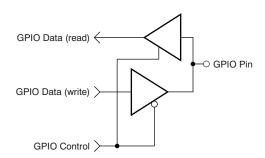


Figure 31. GPIO Port Pin

Power-Down/Reset (PWDN/RESET)

The $\overline{PWDN}/\overline{RESET}$ pins are shared. If $\overline{PWDN}/\overline{RESET}$ is held low for longer than 2^9 t_{MODs} , the device is powered down. The implementation is such that the device is always reset when $PWDN/\overline{RESET}$ makes a transition from high to low. If the device is powered down it is reset first and then if 2^{10} clock elapses it is powered down. Hence, when powering up the device from a power-down state, all registers must be rewritten.

There are two methods to reset the ADS1191/2: pull the $\overline{PWDN/RESET}$ pin low, or send the RESET opcode command. When using the $\overline{PWDN/RESET}$ pin, take it low to force a reset. Make sure to follow the minimum pulse width timing specifications before taking the $\overline{PWDN/RESET}$ pin back high. The RESET command takes effect on the eighth SCLK falling edge of the opcode command. On reset it takes 18 t_{CLK} cycles to complete initialization of the configuration registers to the default states and start the conversion cycle. Note that an internal RESET is automatically issued to the digital filter whenever the CONFIG1 register is set to a new value with a WREG command.



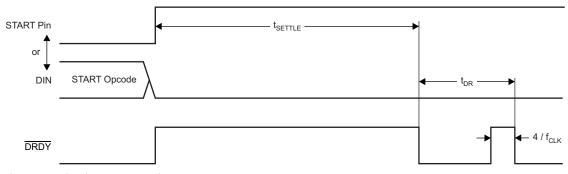
START

The START pin must be set high or the START command sent to begin conversions. When START is low or if the START command has not been sent, the device does not issue a DRDY signal (conversions are halted).

When using the START opcode to control conversion, hold the START pin low. The ADS1191/2 feature two modes to control conversion: continuous mode and single-shot mode. The mode is selected by SINGLE_SHOT (bit 7 of the CONFIG1 register). In multiple device configurations the START pin is used to synchronize devices (see the *Multiple Device Configuration* subsection of the *SPI Interface* section for more details).

Settling Time

The settling time (t_{SETTLE}) is the time it takes for the converter to output fully settled data when the START signal is pulled high. Once START is pulled high, DRDY is also pulled high. The next falling edge of DRDY indicates that data are ready. Figure 32 shows the timing diagram and Table 5 shows the settling time for different data rates. The settling time depends on f_{CLK} and the decimation ratio (controlled by the DR[2:0] bits in the CONFIG1 register). Table 4 shows the settling time as a function of t_{CLK} . Note that when START is held high and there is a step change in the input signal, it takes 3 t_{DR} for the filter to settle to the new value. Settled data are available on the fourth DRDY pulse. Settling time number uncertainty is one t_{MOD} cycle. Therefore, it is recommended to add one t_{MOD} cycle delay before issuing SCLK to retrieve data.



(1) Settling time uncertainty is one t_{MOD} cycle.

Figure 32. Settling Time

SETTLING TIME(1) UNIT(2) DR[2:0] 000 4100 t_{MOD} 001 2052 t_{MOD} 1028 010 t_{MOD} 011 516 t_{MOD} 100 260 t_{MOD} 101 132 t_{MOD} 68 110 t_{MOD} 111

Table 5. Settling Time for Different Data Rates

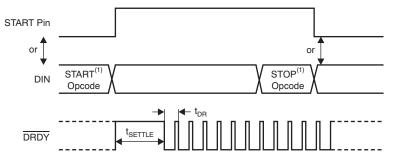
Settling time uncertainty is one t_{MOD} cycle.

⁽²⁾ $t_{MOD} = 4 t_{CLK}$ for CLK_DIV = 0 and $t_{MOD} = 16 t_{CLK}$ for CLK_DIV = 1.



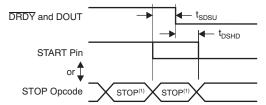
Continuous Mode

Conversions begin when the START pin is taken high or when the START opcode command is sent. As seen in Figure 33, the $\overline{\text{DRDY}}$ output goes high when conversions are started and goes low when data are ready. Conversions continue indefinitely until the START pin is taken low or the STOP opcode command is transmitted. When the START pin is pulled low or the stop command is issued, the conversion in progress is allowed to complete. Figure 34 and Table 6 show the required timing of $\overline{\text{DRDY}}$ to the START pin and the START/STOP opcode commands when controlling conversions in this mode. To keep the converter running continuously, the START pin can be permanently tied high. Note that when switching from pulse mode to continuous mode, the START signal is pulsed or a STOP command must be issued followed by a START command. This conversion mode is ideal for applications that require a fixed continuous stream of conversions results.



(1) START and STOP opcode commands take effect on the seventh SCLK falling edge at the end of the opcode transmission.

Figure 33. Continuous Conversion Mode



(1) START and STOP commands take effect on the seventh SCLK falling edge at the end of the opcode transmission.

Figure 34. START to DRDY Timing

Table 6. Timing Characteristics for Figure 34⁽¹⁾

| SYMBOL | DESCRIPTION | MIN | UNIT |
|-------------------|---|-----|------------------|
| t _{SDSU} | START pin low or STOP opcode to DRDY setup time to halt further conversions | 8 | t _{MOD} |
| t _{DSHD} | START pin low or STOP opcode to complete current conversion | 8 | t _{MOD} |

(1) START and STOP commands take effect on the seventh SCLK falling edge at the end of the opcode transmission.



Single-Shot Mode

The single-shot mode is enabled by setting the SINGLE_SHOT bit in the CONFIG1 register to '1'. In single-shot mode, the ADS1191/2 perform a single conversion when the START pin is taken high or when the START opcode command is sent. As seen in Figure 34, when a conversion is complete, DRDY goes low and further conversions are stopped. Regardless of whether the conversion data are read or not, DRDY remains low. To begin a new conversion, take the START pin low and then back high, or transmit the START opcode again. When switching from continuous mode to pulse mode, make sure the START signal is pulsed or issue a STOP command followed by a START command.

This conversion mode is provided for applications that require non-standard or non-continuous data rates. Issuing a START command or toggling the START pin high resets the digital filter, effectively dropping the data rate by a factor of four. Note that this mode leaves the system more susceptible to aliasing effects, requiring more complex analog anti-aliasing filters at the inputs. Loading on the host processor increases because it must toggle the START pin or send a START command to initiate a new conversion cycle.

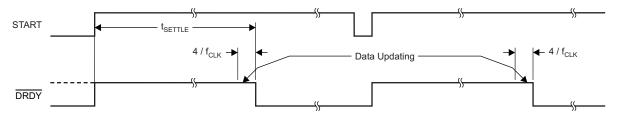


Figure 35. DRDY with No Data Retrieval in Single-Shot Mode

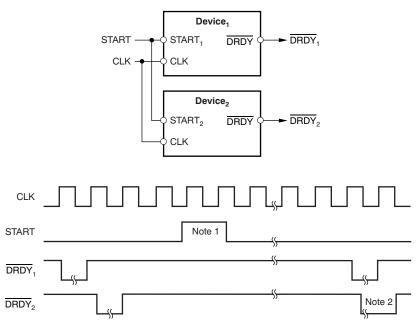
MULTIPLE DEVICE CONFIGURATION

The ADS1191/2 are designed to provide configuration flexibility when <u>multiple</u> devices are used in a system. The serial interface typically needs four signals: DIN, DOUT, SCLK, and \overline{CS} . With one additional chip select signal per device, multiple devices can be connected together. The number of signals needed to interface n devices is 3 + n.

The right leg drive amplifiers can be daisy-chained as explained in the *RLD Configuration with Multiple Devices* subsection of the *ECG-Specific Functions* section. To use the internal oscillator in a daisy-chain configuration, one of the devices must be set as the master for the clock source with the internal oscillator enabled (CLKSEL pin = 1) and the internal oscillator clock brought out of the device by setting the CLK_EN register bit to '1'. This master device clock is used as the external clock source for the other devices.



When using multiple devices, the devices can be synchronized with the START signal. The delay from START to the DRDY signal is fixed for a fixed data rate (see the *START* subsection of the *SPI Interface* section for more details on the settling times). Figure 36 shows the behavior of two devices when synchronized with the START signal.



- (1) Start pulse must be at least one t_{MOD} cycle wide.
- (2) Settling time number uncertainty is one t_{MOD} cycle.

Figure 36. Synchronizing Multiple Converters

Standard Mode

Figure 37 shows a configuration with two devices cascaded together. One of the devices is an ADS1192 (two-channel) and the other is an ADS1192 (two-channel). Together, they create a system with four channels. DOUT, SCLK, and DIN are shared. Each device has its own chip select. When a device is not selected by the corresponding $\overline{\text{CS}}$ being driven to logic 1, the DOUT of this device is high-impedance. This structure allows the other device to take control of the DOUT bus.

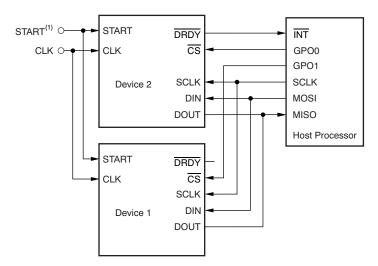


Figure 37. Multiple Device Configurations

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SPI COMMAND DEFINITIONS

The ADS1191/2 provide flexible configuration control. The opcode commands, summarized in Table 7, control and configure the operation of the ADS1191/2. The opcode commands are stand-alone, except for the register read and register write operations that require a second command byte plus data. \overline{CS} can be taken high or held low between opcode commands but must stay low for the entire command operation (especially for multi-byte commands). System opcode commands and the RDATA command are decoded by the ADS1191/2 on the seventh falling edge of SCLK. The register read/write opcodes are decoded on the eighth SCLK falling edge. Be sure to follow SPI timing requirements when pulling \overline{CS} high after issuing a command.

Table 7. Command Definitions

| COMMAND | DESCRIPTION | FIRST BYTE | SECOND BYTE |
|------------------|---|--|----------------------------------|
| System Command | ds | | |
| WAKEUP | Wake-up from standby mode | 0000 0010 (02h) | |
| STANDBY | Enter standby mode | 0000 0100 (04h) | |
| RESET | Reset the device | 0000 0110 (06h) | |
| START | Start/restart (synchronize) conversions | 0000 1000 (08h) | |
| STOP | Stop conversion | 0000 1010 (0Ah) | |
| OFFSETCAL | Channel offset calibration | 0001 1010 (1Ah) | |
| Data Read Comm | ands | | |
| RDATAC | Enable Read Data Continuous mode. This mode is the default mode at power-up. (1) | 0001 0000 (10h) | |
| SDATAC | Stop Read Data Continuously mode | 0001 0001 (11h) | |
| RDATA | Read data by command; supports multiple read back. | 0001 0010 (12h) | |
| Register Read Co | mmands | | |
| RREG | Read <i>n nnnn</i> registers starting at address <i>r rrrr</i> | 001 <i>r rrrr</i> (2xh) ⁽²⁾ | 000 <i>n nnnn</i> ⁽²⁾ |
| WREG | Write <i>n nnnn</i> registers starting at address <i>r rrrr</i> | 010 <i>r rrrr</i> (4xh) ⁽²⁾ | 000 <i>n nnnn</i> ⁽²⁾ |

⁽¹⁾ When in RDATAC mode, the RREG command is ignored.

WAKEUP: Exit STANDBY Mode

This opcode exits the low-power standby mode; see the *STANDBY: Enter STANDBY Mode* subsection of the *SPI Command Definitions* section. Time is required when exiting standby mode (see the Electrical Characteristics for details). **There are no restrictions on the SCLK rate for this command and it can be issued any time.** Any following command must be sent after 4 t_{CLK} cycles.

STANDBY: Enter STANDBY Mode

This opcode command enters the low-power standby mode. All parts of the circuit are shut down except for the reference section. The standby mode power consumption is specified in the Electrical Characteristics. There are no restrictions on the SCLK rate for this command and it can be issued any time. Do not send any other command other than the wakeup command after the device enters the standby mode.

RESET: Reset Registers to Default Values

This command resets the digital filter cycle and returns all register settings to the default values. See the *Reset* (*RESET*) subsection of the *SPI Interface* section for more details. **There are no restrictions on the SCLK rate for this command and it can be issued any time.** It takes 9 f_{MOD} cycles to execute the RESET command. Avoid sending any commands during this time.

⁽²⁾ n nnnn = number of registers to be read/written - 1. For example, to read/write three registers, set n nnnn = 0 (0010). r rrrr = starting register address for read/write opcodes.



START: Start Conversions

This opcode starts data conversions. Tie the START pin low to control conversions by command. If conversions are in progress this command has no effect. The STOP opcode command is used to stop conversions. If the START command is immediately followed by a STOP command then have a gap of 4 t_{CLK} cycles between them. When the START opcode is sent to the device, keep the START pin low until the STOP command is issued. (See the *START* subsection of the *SPI Interface* section for more details.) There are no restrictions on the SCLK rate for this command and it can be issued any time.

STOP: Stop Conversions

This opcode stops conversions. Tie the START pin low to control conversions by command. When the STOP command is sent, the conversion in progress completes and further conversions are stopped. If conversions are already stopped, this command has no effect. There are no restrictions on the SCLK rate for this command and it can be issued any time.

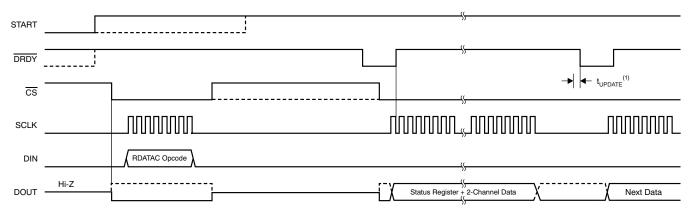
OFFSETCAL: Channel Offset Calibration

This command is used to cancel the channel offset. The CALIB_ON bit in the MISC2 register must be set to '1' before issuing this command. OFFSETCAL must be executed every time there is a change in the PGA gain settings.

RDATAC: Read Data Continuous

This opcode enables the output of conversion data on each $\overline{\text{DRDY}}$ without the need to issue subsequent read data opcodes. This mode places the conversion data in the output register and may be shifted out directly. The read data continuous mode is the default mode of the device and the device defaults in this mode on power-up.

RDATAC mode is cancelled by the Stop Read Data Continuous command. If the device is in RDATAC mode, an SDATAC command must be issued before any other commands can be sent to the device. There is no restriction on the SCLK rate for this command. However, the subsequent data retrieval SCLKs or the SDATAC opcode command should wait at least 4 t_{CLK} cycles. The timing for RDATAC is shown in Figure 38. As Figure 38 shows, there is a *keep out* zone of 4 t_{CLK} cycles around the DRDY pulse where this command cannot be issued in. If no data are retrieved from the device, DOUT and DRDY behave similarly in this mode. To retrieve data from the device after the RDATAC command is issued, make sure either the START pin is high or the START command is issued. Figure 38 shows the recommended way to use the RDATAC command. RDATAC is ideally suited for applications such as data loggers or recorders where registers are set once and do not need to be reconfigured.



(1) $t_{UPDATE} = 4 * t_{CLK}$. Do not read data during this time.

Figure 38. RDATAC Usage



SDATAC: Stop Read Data Continuous

This opcode cancels the Read Data Continuous mode. There is no restriction on the SCLK rate for this command, but the following command must wait for $4 t_{CLK}$ cycles.

RDATA: Read Data

Issue this command after \overline{DRDY} goes low to read the conversion result (in Stop Read Data Continuous mode). There is no restriction on the SCLK rate for this command, and there is no wait time needed for the subsequent commands or data retrieval SCLKs. To retrieve data from the device after the RDATA command is issued, make sure either the START pin is high or the START command is issued. When reading data with the RDATA command, the read operation can overlap the occurrence of the next \overline{DRDY} without data corruption. Figure 39 shows the recommended way to use the RDATA command. RDATA is best suited for ECG- and EEG-type systems where register setting must be read or changed often between conversion cycles.

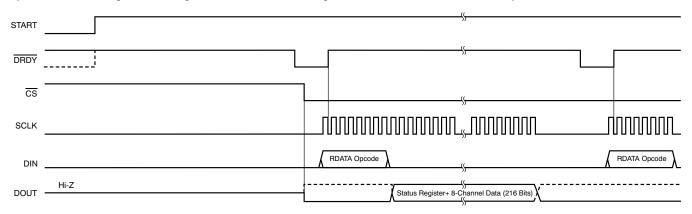


Figure 39. RDATA Usage

Sending Multi-Byte Commands

The ADS1191/2 serial interface decodes commands in bytes and requires 4 t_{CLK} cycles to decode and execute. Therefore, when sending multi-byte commands, a 4 t_{CLK} period must separate the end of one byte (or opcode) and the next.

Assume CLK is 512 kHz, then $t_{SDECODE}$ (4 t_{CLK}) is 7.8125 µs. When SCLK is 16 MHz, one byte can be transferred in 500 ns. This byte transfer time does not meet the $t_{SDECODE}$ specification; therefore, a delay must be inserted so the end of the second byte arrives 7.3125 µs later. If SCLK is 1 MHz, one byte is transferred in 8 µs. Because this transfer time exceeds the $t_{SDECODE}$ specification, the processor can send subsequent bytes without delay. In this later scenario, the serial port can be programmed to cease single-byte transfer per cycle to multiple bytes.



RREG: Read From Register

This opcode reads register data. The Register Read command is a two-byte opcode followed by the output of the register data. The first byte contains the command opcode and the register address. The second byte of the opcode specifies the number of registers to read – 1.

First opcode byte: 001*r rrrr*, where *r rrrr* is the starting register address.

Second opcode byte: 000*n nnnn*, where *n nnnn* is the number of registers to read – 1.

The 17th SCLK rising edge of the operation clocks out the MSB of the first register, as shown in Figure 40. When the device is in read data continuous mode it is necessary to issue a SDATAC command before the RREG command can be issued. The RREG command can be issued any time. However, because this command is a multi-byte command, there are restrictions on the SCLK rate depending on the way the SCLKs are issued. See the Serial Clock (SCLK) subsection of the SPI Interface section for more details. Note that CS must be low for the entire command.

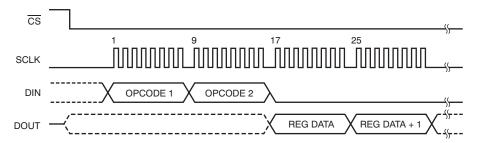


Figure 40. RREG Command Example: Read Two Registers Starting from Register 00h (ID Register) (OPCODE 1 = 0010 0000, OPCODE 2 = 0000 0001)

WREG: Write to Register

This opcode writes register data. The Register Write command is a two-byte opcode followed by the input of the register data. The first byte contains the command opcode and the register address.

The second byte of the opcode specifies the number of registers to write -1.

First opcode byte: 010*r rrrr*, where *r rrrr* is the starting register address.

Second opcode byte: 000*n nnnn*, where *n nnnn* is the number of registers to write – 1.

After the opcode bytes, the register data follows (in MSB-first format), as shown in Figure 41. The WREG command can be issued any time. However, because this command is a multi-byte command, there are restrictions on the SCLK rate depending on the way the SCLKs are issued. See the Serial Clock (SCLK) subsection of the SPI Interface section for more details. Note that $\overline{\text{CS}}$ must be low for the entire command.

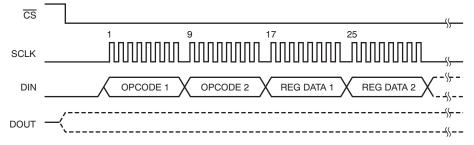


Figure 41. WREG Command Example: Write Two Registers Starting from 00h (ID Register) (OPCODE 1 = 0100 0000, OPCODE 2 = 0000 0001)



REGISTER MAP

Table 8 describes the various ADS1191/2 registers.

Table 8. Register Assignments

| ADDRESS | REGISTER | RESET VALUE (Hex) | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------------|--------------------|-------------------------|-----------------|-------------------|------------|-------------------------|------------|------------|------------|-----------|
| Device Settin | gs (Read-Only Regi | sters) | | | ' | | | | 1 | |
| 00h | ID | XX | REV_ID7 | REV_ID6 | REV_ID5 | 1 | 0 | 0 | REV_ID1 | REV_ID0 |
| Global Setting | gs Across Channels | s | | | | | | | | |
| 01h | CONFIG1 | 02 | SINGLE_ SHOT | 0 | 0 | 0 | 0 | DR2 | DR1 | DR0 |
| 02h | CONFIG2 | 80 | 1 | PDB_LOFF_ COMP | PDB_REFBUF | VREF_4V | CLK_EN | 0 | INT_TEST | TEST_FREQ |
| 03h | LOFF | 10 | COMP_TH2 | COMP_TH1 | COMP_TH0 | 1 | ILEAD_OFF1 | ILEAD_OFF0 | 0 | FLEAD_OFF |
| Channel-Spec | ific Settings | | 1 | 1 | | | | 1 | | |
| 04h | CH1SET | 00 | PD1 | GAIN1_2 | GAIN1_1 | GAIN1_0 | MUX1_3 | MUX1_2 | MUX1_1 | MUX1_0 |
| 05h | CH2SET | 00 | PD2 | GAIN2_2 | GAIN2_1 | GAIN2_0 | MUX2_3 | MUX2_2 | MUX2_1 | MUX2_0 |
| 06h | RLD_SENS | 00 | 0 | 0 | PDB_RLD | RLD_LOFF_ SENS | RLD2N | RLD2P | RLD1N | RLD1P |
| 07h | LOFF_SENS | 00 | 0 | 0 | FLIP2 | FLIP1 | LOFF2N | LOFF2P | LOFF1N | LOFF1P |
| 08h | LOFF_STAT | 00 | 0 | CLK_DIV | 0 | RLD_STAT (read only) | IN2N_OFF | IN2P_OFF | IN1N_OFF | IN1P_OFF |
| GPIO and Oth | er Registers | | | | | | | | | |
| 09h | MISC1 | 00 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| 0Ah | MISC2 | 02 | CALIB_ON | 0 | 0 | 0 | 0 | 0 | RLDREF_INT | 0 |
| 0Bh | GPIO | 0C | 0 | 0 | 0 | 0 | GPIOC2 | GPIOC1 | GPIOD2 | GPIOD1 |

User Register Description

ID: ID Control Register (Factory-Programmed, Read-Only)

Address = 00h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|---------|---------|---------|-------|-------|-------|---------|---------|
| REV_ID7 | REV_ID6 | REV_ID5 | 1 | 0 | 0 | REV_ID1 | REV_ID0 |

The ID Control Register is programmed during device manufacture to indicate device characteristics.

Bits[7:5] REV_ID[7:5]: Revision identification

000 = Reserved

001 = Reserved

010 = ADS1x9x device

011 = ADS1292R device

100 = Reserved

101 = Reserved

110 = Reserved

111 = Reserved

Bit 4 Reads high

Bits[3:2] Reads low

Bits[1:0] REV_ID[1:0]: Revision identification

00 = ADS1191

01 = ADS1192

10 = ADS1291

11 = ADS1292/2R

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CONFIG1: Configuration Register 1

Address = 01h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------|-------|-------|-------|-------|-------|-------|-------|
| SINGLE_SHOT | 0 | 0 | 0 | 0 | DR2 | DR1 | DR0 |

Configuration Register 1 configures each ADC channel sample rate.

Bit 7 SINGLE_SHOT: Single-shot conversion

This bit sets the conversion mode

0 = Continuous conversion mode (default)

1 = Single-shot mode

Bits[6:3] Must be set to '0'

Bits[2:0] DR[2:0]: Channel oversampling ratio

These bits determine the oversampling ratio of both channel 1 and channel 2.

| BIT | OVERSAMPLING RATIO | DATA RATE ⁽¹⁾ |
|-----|------------------------|--------------------------|
| 000 | f _{MOD} /1024 | 125 SPS |
| 001 | f _{MOD} /512 | 250 SPS |
| 010 | f _{MOD} /256 | 500 SPS (default) |
| 011 | f _{MOD} /128 | 1 kSPS |
| 100 | f _{MOD} /64 | 2 kSPS |
| 101 | f _{MOD} /32 | 4 kSPS |
| 110 | f _{MOD} /16 | 8 kSPS |
| 111 | Do not use | Do not use |

⁽¹⁾ f_{CLK} = 512 kHz and CLK_DIV = 0 or f_{CLK} = 2.048 MHz and CLK_DIV = 1.



CONFIG2: Configuration Register 2

Address = 02h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------------------|------------|---------|--------|-------|----------|-----------|
| 1 | PDB_LOFF_ COMP | PDB_REFBUF | VREF_4V | CLK_EN | 0 | INT_TEST | TEST_FREQ |

Configuration Register 2 configures the test signal, clock, reference, and LOFF buffer.

Bit 7 Must be set to '1'

Bit 6 PDB_LOFF_COMP: Lead-off comparator power-down

This bit powers down the lead-off comparators.

0 = Lead-off comparators disabled (default)

1 = Lead-off comparators enabled

Bit 5 PDB_REFBUF: Reference buffer power-down

This bit powers down the internal reference buffer so that the external reference can be used.

0 = Reference buffer is powered down (default)

1 = Reference buffer is enabled

Bit 4 VREF 4V: Enables 4-V reference

This bit chooses between 2.42-V and 4.033-V reference.

0 = 2.42-V reference (default)

1 = 4.033-V reference

Bit 3 CLK EN: CLK connection

This bit determines if the internal oscillator signal is connected to the CLK pin when an internal oscillator is used.

0 = Oscillator clock output disabled (default)

1 = Oscillator clock output enabled

Bit 2 Must be set to '0'

Bit 1 INT_TEST: Test signal selection

This bit determines whether the test signal is turned on or off.

0 = Off (default)

1 = On; amplitude = \pm (VREFP - VREFN)/2420

Bit 0 TEST_FREQ: Test signal frequency.

This bit determines the test signal frequency.

0 = At dc (default)

1 = Square wave at 1 Hz



LOFF: Lead-Off Control Register

Address = 03h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------|----------|----------|-------|------------|------------|-------|-----------|
| COMP_TH2 | COMP_TH1 | COMP_TH0 | 1 | ILEAD_OFF1 | ILEAD_OFF0 | 0 | FLEAD_OFF |

The Lead-Off Control Register configures the Lead-Off detection operation.

Bits[7:5] COMP_TH[2:0]: Lead-off comparator threshold

These bits determine the lead-off comparator threshold. See the *Lead-Off Detection* subsection of the *ECG-Specific Functions* section for a detailed description.

Comparator positive side

000 = 95% (default) 001 = 92.5% 010 = 90% 011 = 87.5% 100 = 85% 101 = 80% 110 = 75% 111 = 70%

Comparator negative side

000 = 5% (default) 001 = 7.5% 010 = 10% 011 = 12.5% 100 = 15% 101 = 20% 110 = 25% 111 = 30%

Bit 4 Must be set to '1'

Bits[3:2] ILEAD_OFF[1:0]: Lead-off current magnitude

These bits determine the magnitude of current for the current lead-off mode.

00 = 6 nA (default) 01 = 22 nA 10 = 6 μA 11 = 22 μA

Bit 1 Must be set to '0'

Bit 0 FLEAD_OFF: Lead-off frequency

This bit selects ac or dc lead-off. 0 = At dc lead-off detect (default)

1 = At ac lead-off detect at f_{DR}/4 (500 Hz for an 2-kHz output rate)



CH1SET: Channel 1 Settings

Address = 04h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|---------|---------|---------|--------|--------|--------|--------|
| PD1 | GAIN1_2 | GAIN1_1 | GAIN1_0 | MUX1_3 | MUX1_2 | MUX1_1 | MUX1_0 |

The CH1SET Control Register configures the power mode, PGA gain, and multiplexer settings channels. See the *Input Multiplexer* section for details.

Bit 7 PD1: Channel 1 power-down

0 = Normal operation (default) 1 = Channel 1 power-down

Bits[6:4] GAIN1[2:0]: Channel 1 PGA gain setting

These bits determine the PGA gain setting for channel 1.

000 = 6 (default) 001 = 1010 = 2

011 = 3 100 = 4

101 = 8110 = 12

111 = Not available

Bits[3:0] MUX1[3:0]: Channel 1 input selection

These bits determine the channel 1 input selection.

0000 = Normal electrode input (default)

0001 = Input shorted (for offset measurements)

0010 = RLD_MEASURE

0011 = MVDD for supply measurement

0100 = Temperature sensor

0101 = Test signal

0110 = RLD_DRP (positive input is connected to RLDIN) 0111 = RLD_DRM (negative input is connected to RLDIN)

1000 = RLD_DRPM (both positive and negative inputs are connected to RLDIN)

1001 = Route IN3P and IN3N to channel 1 inputs

1010 = Reserved

1011 = Reserved

1100 = Reserved

1101 = Reserved

1110 = Reserved

1111 = Reserved

Product Folder Links: ADS1191 ADS1192

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CH2SET: Channel 2 Settings

Address = 05h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|---------|---------|---------|--------|--------|--------|--------|
| PD2 | GAIN2_2 | GAIN2_1 | GAIN2_0 | MUX2_3 | MUX2_2 | MUX2_1 | MUX2_0 |

The CH2SET Control Register configures the power mode, PGA gain, and multiplexer settings channels. See the *Input Multiplexer* section for details.

Bit 7 PD2: Channel 2 power-down

0 = Normal operation (default) 1 = Channel 2 power-down

Bits[6:4] GAIN2[2:0]: Channel 2 PGA gain setting

These bits determine the PGA gain setting for channel 2.

000 = 6 (default)

001 = 1

010 = 2

011 = 3

100 = 4

101 = 8

110 = 12

Bits[3:0] MUX2[3:0]: Channel 2 input selection

These bits determine the channel 2 input selection.

0000 = Normal electrode input (default)

0001 = Input shorted (for offset measurements)

0010 = RLD_MEASURE

0011 = VDD/2 for supply measurement

0100 = Temperature sensor

0101 = Test signal

0110 = RLD_DRP (positive electrode is the driver)

0111 = RLD_DRM (negative electrode is the driver)

1000 = Reserved

1001 = Route IN3P and IN3N to channel 2 inputs

1010 = Reserved

1011 = Reserved 1100 = Reserved

1101 = Reserved

1110 = Reserved

1111 = Reserved



RLD SENS: Right Leg Drive Sense Selection

Address = 06h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|---------|-------------------|-------|-------|-------|-------|
| 0 | 0 | PDB_RLD | RLD_LOFF_ SENS | RLD2N | RLD2P | RLD1N | RLD1P |

This register controls the selection of the positive and negative signals from each channel for right leg drive derivation. See the *Right Leg Drive (RLD DC Bias Circuit)* subsection of the *ECG-Specific Functions* section for details.

Bits[7:6] Must be set to '0'

Bit 5 PDB_RLD: RLD buffer power

This bit determines the RLD buffer power state. 0 = RLD buffer is powered down (default)

1 = RLD buffer is enabled

Bit 4 RLD_LOFF_SENSE: RLD lead-off sense function

This bit enables the RLD lead-off sense function. 0 = RLD lead-off sense is disabled (default)

1 = RLD lead-off sense is enabled

Bit 3 RLD2N: Channel 2 RLD negative inputs

This bit controls the selection of negative inputs from channel 2 for right leg drive derivation.

0 = Not connected (default) 1 = RLD connected to IN2N

Bit 2 RLD2P: Channel 2 RLD positive inputs

This bit controls the selection of positive inputs from channel 2 for right leg drive derivation.

0 = Not connected (default) 1 = RLD connected to IN2P

Bit 1 RLD1N: Channel 1 RLD negative inputs

This bit controls the selection of negative inputs from channel 1 for right leg drive derivation.

0 = Not connected (default) 1 = RLD connected to IN1N

Bit 0 RLD1P: Channel 1 RLD positive inputs

This bit controls the selection of positive inputs from channel 1 for right leg drive derivation.

0 = Not connected (default) 1 = RLD connected to IN1P

Product Folder Links: ADS1191 ADS1192



LOFF SENS: Lead-Off Sense Selection

Address = 07h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|--------|--------|--------|--------|
| 0 | 0 | FLIP2 | FLIP1 | LOFF2N | LOFF2P | LOFF1N | LOFF1P |

This register selects the positive and negative side from each channel for lead-off detection. See the *Lead-Off Detection* subsection of the *ECG-Specific Functions* section for details. Note that the LOFF_STAT register bits should be ignored if the corresponding LOFF_SENS bits are set to '1'.

Bits[7:6] Must be set to '0'

Bit 5 FLIP2: Current direction selection

This bit controls the direction of the current used for lead-off derivation for channel 2.

0 = Disabled (default)

1 = Enabled

Bit 4 FLIP1: Current direction selection

This bit controls the direction of the current used for lead-off derivation for channel 1.

0 = Disabled (default)

1 = Enabled

Bit 3 LOFF2N: Channel 2 lead-off detection negative inputs

This bit controls the selection of negative input from channel 2 for lead-off detection.

0 = Disabled (default)

1 = Enabled

Bit 2 LOFF2P: Channel 2 lead-off detection positive inputs

This bit controls the selection of positive input from channel 2 for lead-off detection.

0 = Disabled (default)

1 = Enabled

Bit 1 LOFF1N: Channel 1 lead-off detection negative inputs

This bit controls the selection of negative input from channel 1 for lead-off detection.

0 = Disabled (default)

1 = Enabled

Bit 0 LOFF1P: Channel 1 lead-off detection positive inputs

This bit controls the selection of positive input from channel 1 for lead-off detection.

0 = Disabled (default)

1 = Enabled



LOFF STAT: Lead-Off Status

Address = 08h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|---------|-------|----------------------|-------------------------|----------------------|-------------------------|-------------------------|
| 0 | CLK_DIV | 0 | RLD_STAT (read only) | IN2N_OFF (read only) | IN2P_OFF (read only) | IN1N_OFF (read only) | IN1P_OFF (read only) |

This register stores the status of whether the positive or negative electrode on each channel is on or off. See the *Lead-Off Detection* subsection of the *ECG-Specific Functions* section for details. Ignore the LOFF_STAT values if the corresponding LOFF_SENS bits are not set to '1'.

'0' is lead-on (default) and '1' is lead-off. When the LOFF_SENS bits[3:0] are '0', the LOFF_STAT bits should be ignored.

Bit 7 Must be set to '0'

Bit 6 CLK_DIV: Clock divider selection

This bit sets the divider ratio between f_{CLK} and f_{MOD} . Two external clock values are supported: 512 kHz and 2.048 MHz.

This bit must be set so that $f_{MOD} = 128 \text{ kHz}$. $0 = f_{MOD}/4$ (default, when $f_{CLK} = 512 \text{ kHz}$)

 $1 = f_{MOD}/16$ (when $f_{CLK} = 2.048$ MHz)

Bit 5 Must be set to '0'

Bit 4 RLD_STAT: RLD lead-off status

This bit determines the status of RLD.

0 = RLD is connected (default) 1 = RLD is not connected

Bit 3 IN2N_OFF: Channel 2 negative electrode status

This bit determines if the channel 2 negative electrode is connected or not.

0 = Connected (default)

1 = Not connected

Bit 2 IN2P_OFF: Channel 2 positive electrode status

This bit determines if the channel 2 positive electrode is connected or not.

0 = Connected (default)

1 = Not connected

Bit 1 IN1N_OFF: Channel 1 negative electrode status

This bit determines if the channel 1 negative electrode is connected or not.

0 = Connected (default)

1 = Not connected

Bit 0 IN1P_OFF: Channel 1 positive electrode status

This bit determines if the channel 1 positive electrode is connected or not.

0 = Connected (default)

1 = Not connected



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MISC1: Miscellaneous Control Register 1

Address = 09h

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

This register controls the miscellaneous functionality. For the ADS1191 and ADS1192 devices, 02h must be written to the MISC1 register.

Bits[7:2] Must be set to '0' Must be set to '1' Bit 6 Bit 0 Must be set to '0'

MISC2: Miscellaneous Control Register 2

Address = 0Ah

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------|-------|-------|-------|-------|-------|------------|-------|
| CALIB_ON | 0 | 0 | 0 | 0 | 0 | RLDREF_INT | 0 |

This register controls the calibration functionality.

Bit 7 CALIB_ON: Calibration on

This bit is used to enable offset calibration.

0 = Off (default)

1 = On

Bits[6:2] Must be '0'

RLDREF_INT: RLDREF signal Bit 1

This bit determines the RLDREF signal source.

0 = RLDREF is external (default) 1 = RLDREF is fed internally

Bit 0 Must be set to '0'

GPIO: General-Purpose I/O Register

Address = 0Bh

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|--------|--------|--------|--------|
| 0 | 0 | 0 | 0 | GPIOC2 | GPIOC1 | GPIOD2 | GPIOD1 |

This register controls the GPIO pins.

Bits[7:4] Must be '0'

Bits[3:2] GPIOC[2:1]: GPIO 1 and 2 control

These bits determine if the corresponding GPIOD pin is an input or output.

0 = Output

1 = Input (default)

Bits[1:0] GPIOD[2:1]: GPIO 1 and 2 data

These bits are used to read and write data to the GPIO ports.

When reading the register, the data returned correspond to the state of the GPIO external pins, whether they are programmed as inputs or as outputs. As outputs, a write to the GPIOD sets the output value. As inputs, a write to the

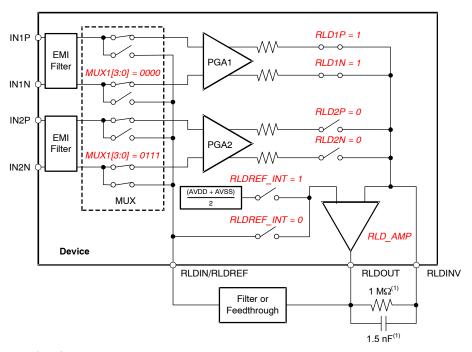
GPIOD has no effect.



ECG-SPECIFIC FUNCTIONS

INPUT MULTIPLEXER (REROUTING THE RIGHT LEG DRIVE SIGNAL)

The input multiplexer has ECG-specific functions for the right leg drive signal. The RLD signal is available at the RLDOUT pin once the appropriate channels are selected for the RLD derivation, feedback elements are installed external to the chip, and the loop is closed. This signal can be fed after filtering or fed directly into the RLDIN pin as shown in Figure 42. This RLDIN signal can be multiplexed into any one of the input electrodes by setting the MUX bits of the appropriate channel set registers to '0110' for P-side or '0111' for N-side. Figure 42 shows the RLD signal generated from channel 1 and routed to the N-side of channel 2. This feature can be used to dynamically change the electrode that is used as the reference signal to drive the patient body. Note that the corresponding channel cannot be used and can be powered down.



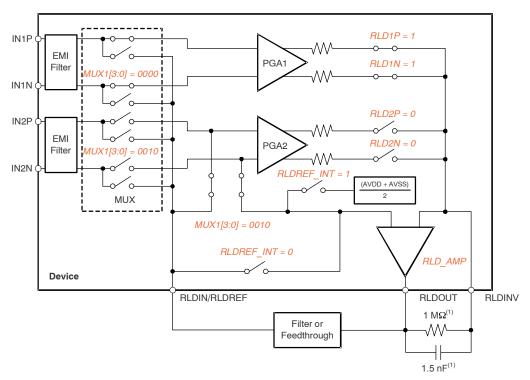
(1) Typical values for example only.

Figure 42. Example of RLDOUT Signal Configured to be Routed to IN2N



Input Multiplexer (Measuring the Right Leg Drive Signal)

Also, the RLDOUT signal can be routed to a channel (that is not used for the calculation of RLD) for measurement. Figure 43 shows the register settings to route the RLDIN signal to channel 2. The measurement is done with respect to the voltage on the RLDREF pin. If RLDREF is chosen to be internal, it would be at (AVDD + AVSS)/2. This feature is useful for debugging purposes during product development.



(1) Typical values for example only.

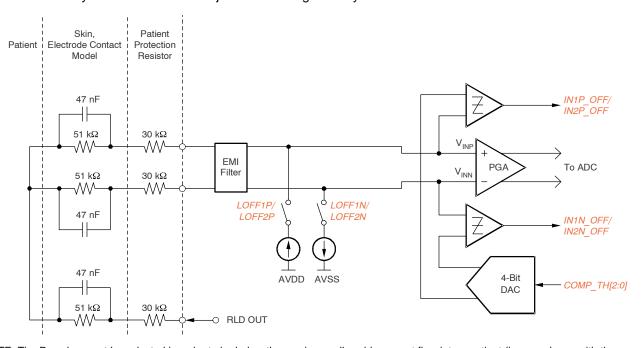
Figure 43. RLDOUT Signal Configured to be Read Back by Channel 2



LEAD-OFF DETECTION

Patient electrode impedances are known to decay over time. It is necessary to continuously monitor these electrode connections to verify a suitable connection is present. The ADS1191/2 lead-off detection functional block provides significant flexibility to the user to choose from various lead-off detection strategies. Though called lead-off detection, this is in fact an *electrode-off* detection.

The basic principle is to inject an excitation signal and measure the response to find out if the electrode is off. As shown in the lead-off detection functional block diagram in Figure 44, this circuit provides two different methods of determining the state of the patient electrode. The methods differ in the frequency content of the excitation signal. Lead-off can be selectively done on a per channel basis using the LOFF_SENS register. Also, the internal excitation circuitry can be disabled and just the sensing circuitry can be enabled.



NOTE: The R_P value must be selected in order to be below the maximum allowable current flow into a patient (in accordance with the relevant specification the latest revision of IEC 60601).

Figure 44. Lead-Off Detection



DC Lead-Off

In this method, the lead-off excitation is with a dc signal. The dc excitation signal can be chosen from either an external pull-up/pull-down resistor or a current source/sink, as shown in Figure 45. One side of the channel is pulled to supply and the other side is pulled to ground. The internal current source and current sink can be swapped by setting thebits in the LOFF_FLIP register. In case of current source/sink, the magnitude of the current can be set by using the ILEAD_OFF[1:0] bits in the LOFF register. The current source/sink gives larger input impedance compared to the $10\text{-M}\Omega$ pull-up/pull-down resistor.

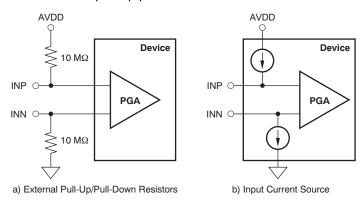


Figure 45. DC Lead-Off Excitation Options

Sensing of the response can be done either by looking at the digital output code from the device or by monitoring the input voltages with an on-chip comparator. If either of the electrodes is off, the pull-up resistors and/or the pull-down resistors saturate the channel. By looking at the output code it can be determined that either the P-side or the N-side is off. To pinpoint which one is off, the comparators must be used. The input voltage is also monitored using a comparator and a 4-bit digital-to-analog converter (DAC) whose levels are set by the COMP_TH[2:0] bits in the LOFF register. The output of the comparators are stored in the LOFF_STAT register. These two registers are available as a part of the output data stream. (See the *Data Output Protocol (DOUT)* subsection of the SPI Interface section.) If dc lead-off is not used, the lead-off comparators can be powered down by setting the PD_LOFF_COMP bit in the CONFIG2 register.

An example procedure to turn on dc lead-off is given in the Lead-Off subsection of the Quick-Start Guide section.

AC Lead-Off

In this method, an out-of-band ac signal is used for excitation. The ac signal is generated by alternatively providing an internal current source and current sink at the input with a fixed frequency. The excitation frequency is a function of the output data rate and is $f_{DR}/4$. This out-of-band excitation signal is passed through the channel and measured at the output.

Sensing of the ac signal is done by passing the signal through the channel to digitize it and measure at the output. The ac excitation signals are introduced at a frequency that is above the band of interest, generating an out-of-band differential signal that can be filtered out separately and processed. By measuring the magnitude of the excitation signal at the output spectrum, the lead-off status can be calculated. Therefore, the ac lead-off detection can be accomplished simultaneously with the ECG signal acquisition.

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RLD Lead-Off

The ADS1191/2 provide two modes for determining whether the RLD is correctly connected:

- RLD lead-off detection during normal operation
- RLD lead-off detection during power-up

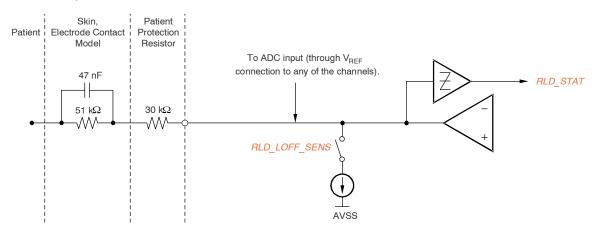
The following sections provide details of the two modes of operation.

RLD Lead-Off Detection During Normal Operation

During normal operation, the ADS1191/2 RLD lead-off at power-up function cannot be used because it is necessary to power off the RLD amplifier.

RLD Lead-Off Detection At Power-Up

This feature is included in the ADS1191/2 for use in determining whether the right leg electrode is suitably connected. At power-up, the ADS1191/2 provides a procedure to determine the RLD electrode connection status using a current sink, as shown in Figure 46. The reference level of the comparator is set to determine the acceptable RLD impedance threshold.



NOTE: The R_P value must be selected in order to be below the maximum allowable current flow into a patient (in accordance with the relevant specification the latest revision of IEC 60601).

Figure 46. RLD Lead-Off Detection at Power-Up

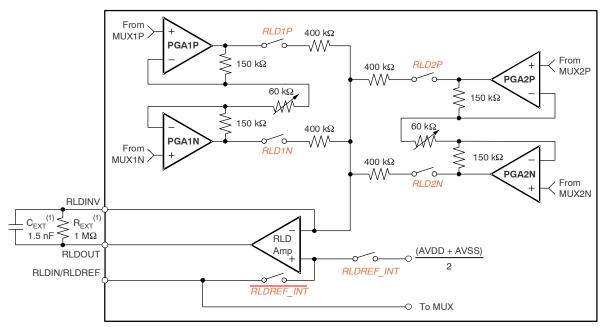
When the RLD amplifier is powered on, the current source has no function. Only the comparator can be used to sense the voltage at the output of the RLD amplifier. The comparator thresholds are set by the same LOFF[7:5] bits used to set the thresholds for other negative inputs.

Submit Documentation Feedback



Right Leg Drive (RLD DC Bias Circuit)

The right leg drive (RLD) circuitry is used as a means to counter the common-mode interference in an ECG system as a result of power lines and other sources, including fluorescent lights. The RLD circuit senses the common-mode of a selected set of electrodes and creates a negative feedback loop by driving the body with an inverted common-mode signal. The negative feedback loop restricts the common-mode movement to a narrow range, depending on the loop gain. Stabilizing the entire loop is specific to the individual user system based on the various poles in the loop. The ADS1191/2 integrates the muxes to select the channel and an operational amplifier. All the amplifier terminals are available at the pins, allowing the user to choose the components for the feedback loop. The circuit shown in Figure 47 shows the overall functional connectivity for the RLD bias circuit.



(1) Typical values.

Figure 47. RLD Channel Selection



The reference voltage for the right leg drive can be chosen to be internally generated (AVDD + AVSS)/2 or it can be provided externally with a resistive divider. The selection of an internal versus external reference voltage for the RLD loop is defined by writing the appropriate value to the RLDREF_INT bit in the MISC2 register.

If the RLD function is not used, the amplifier can be powered down using the PDB_RLD bit. This bit is also used in daisy-chain mode to power-down all but one of the RLD amplifiers.

The functionality of the RLDIN pin is explained in the *Input Multiplexer* section. An example procedure to use the RLD amplifier is shown in the *Right Leg Drive* subsection of the *Quick-Start Guide* section.

RLD Configuration with Multiple Devices

Figure 48 shows multiple devices connected to an RLD.

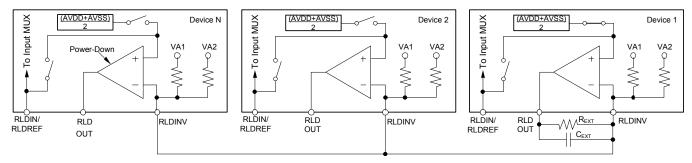


Figure 48. RLD Connection for Multiple Devices



QUICK-START GUIDE

PCB LAYOUT

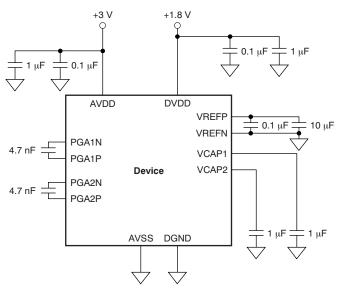
Power Supplies and Grounding

The ADS1191/2 have two supplies: AVDD and DVDD. AVDD should be as quiet as possible. AVDD provides the supply to the charge pump block and has transients at f_{CLK} . It is important to eliminate noise from AVDD that is non-synchronous with the ADS1191/2 operation. Each supply of the ADS1191/2 should be bypassed with 10- μ F and a 0.1- μ F solid ceramic capacitors. It is recommended that placement of the digital circuits (DSP, microcontrollers, FPGAs, etc.) in the system is done such that the return currents on those devices do not cross the analog return path of the ADS1191/2. The ADS1191/2 can be powered from unipolar or bipolar supplies.

The capacitors used for decoupling can be of the surface-mount, low-cost, low-profile multi-layer ceramic type. In most cases the VCAP1 capacitor can also be a multi-layer ceramic, but in systems where the board is subjected to high or low frequency vibration, it is recommend that a non-ferroelectric capacitor such as a tantalum or class 1 capacitor (for example, C0G or NPO) be installed. EIA class 2 and class 3 dielectrics (such as X7R, X5R, X8R, etc.) are ferroelectric. The piezoelectric property of these capacitors can appear as electrical noise coming from the capacitor. When using internal reference, noise on the VCAP1 node results in performance degradation.

Connecting the Device to Unipolar (+3 V/+1.8 V) Supplies

Figure 49 illustrates the ADS1191/2 connected to a unipolar supply. In this example, the analog supply (AVDD) is referenced to analog ground (AVSS) and the digital supply (DVDD) is referenced to digital ground (DGND).



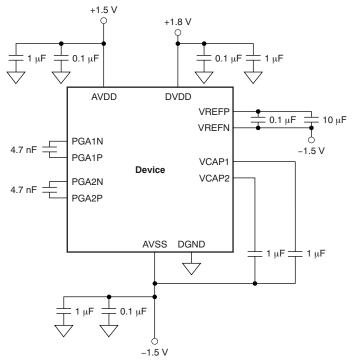
NOTE: Place the capacitors for supply, reference, VCAP1, and VCAP2 as close to the package as possible.

Figure 49. Single-Supply Operation



Connecting the Device to Bipolar (±1.5 V/1.8 V) Supplies

Figure 50 illustrates the ADS1191/2 connected to a bipolar supply. In this example, the analog supplies connect to the device analog supply (AVDD). This supply is referenced to the device analog return (AVSS), and the digital supply (DVDD) is referenced to the device digital ground return (DGND).



NOTE: Place the capacitors for supply, reference, VCAP1, and VCAP2 as close to the package as possible.

Figure 50. Bipolar Supply Operation

Shielding Analog Signal Paths

As with any precision circuit, careful PCB layout ensures the best performance. It is essential to make short, direct interconnections and avoid stray wiring capacitance—particularly at the analog input pins and AVSS. These analog input pins are high-impedance and extremely sensitive to extraneous noise. The AVSS pin should be treated as a sensitive analog signal and connected directly to the supply ground with proper shielding. Leakage currents between the PCB traces can exceed the input bias current of the ADS1191/2 if shielding is not implemented. Digital signals should be kept as far as possible from the analog input signals on the PCB.



POWER-UP SEQUENCING

Before device power-up, all digital and analog inputs must be low. At the time of power-up, all of these signals should remain low until the power supplies have stabilized, as shown in Figure 51. At this time, begin supplying the master clock signal to the CLK pin. Wait for time t_{POR}, then transmit a RESET pulse. After releasing RESET, the configuration register must be programmed, see the *CONFIG1: Configuration Register 1* subsection of the *Register Map* section for details. The power-up sequence timing is shown in Table 9.

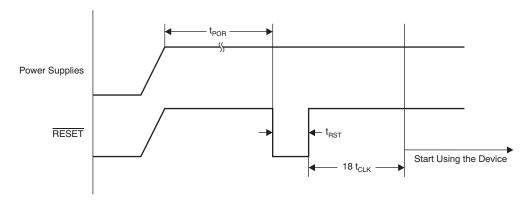


Figure 51. Power-Up Timing Diagram

Table 9. Power-Up Sequence Timing

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNIT |
|------------------|---------------------------------|-----------------|-----|-----|------------------|
| t _{POR} | Wait after power-up until reset | 2 ¹¹ | | | t _{MOD} |
| t _{RST} | Reset low width | 1 | | | t _{MOD} |

SETTING THE DEVICE FOR BASIC DATA CAPTURE

The following section outlines the procedure to configure the device in a basic state and capture data. This procedure is intended to put the device in a data sheet condition to check if the device is working properly in the user's system. It is recommended that this procedure be followed initially to get familiar with the device settings. Once this procedure has been verified, the device can be configured as needed. For details on the timings for commands refer to the appropriate sections in the data sheet. Also, some sample programming codes are added for the ECG-specific functions.



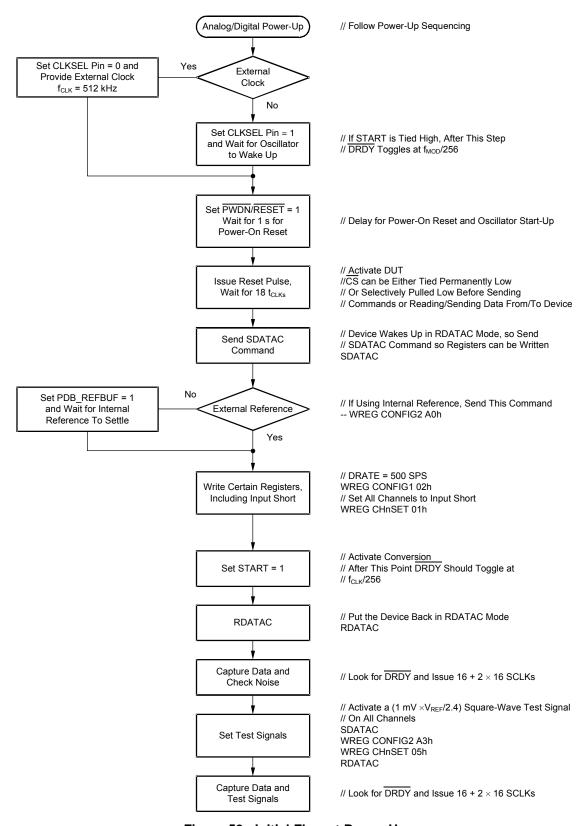


Figure 52. Initial Flow at Power-Up

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Lead-Off

Sample code to set dc lead-off with current source/sink resistors on all channels

WREG LOFF 10h // Comparator threshold at 95% and 5%, current source/sink resistor // DC lead-off

WREG CONFIG2 E0h // Turn-on dc lead-off comparators

WREG LOFF_SENS 0Fh // Turn on both P- and Nside of all channels for lead-off sensing

Observe the status bits of the output data stream to monitor lead-off status.

Right Leg Drive

Sample code to choose RLD as an average of the first three channels.

WREG RLD_SENSP 07h // Select channel 1—3 P-side for RLD sensing

WREG RLD_SENSN 07h // Select channel 1—3 N-side for RLD sensing

WREG CONFIG3 b'x1xx 1100 // Turn on RLD amplifier, set internal RLDREF voltage

Sample code to route the RLD_OUT signal through channel 4 N-side and measure RLD with channel 5. Make sure the external side to the chip RLDOUT is connected to RLDIN.

WREG CONFIG3 b'xxx1 1100 // Turn on RLD amplifier, set internal RLDREF voltage, set RLD measurement bit

WREG CH4SET b'1xxx 0111 // Route RLDIN to channel 4 N-side

WREG CH5SET b'1xxx 0010 // Route RLDIN to be measured at channel 5 w.r.t RLDREF



REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | nanges from Original (December 2011) to Revision A | Page |
|----|---|--------------|
| • | Added RSM data to Family and Ordering Information table | 2 |
| • | Changed AVSS to DGND row in Absolute Maximum Ratings table | 2 |
| • | Changed Channel Performance (AC performance), SNR typical specification in Electrical Characteristics table | 3 |
| • | Changed Supply Current parameters in Electrical Characteristics table | 5 |
| • | Changed ADS1192/2R to ADS1192 in 3 V Power Dissipation, Quiescent power dissipation parameter of Electrical Characteristics table | 6 |
| • | Added RSM pinout package | g |
| • | Changed f _{CLK} to f _{MOD} in bit 6 description of LOFF_STAT: Lead-Off Status register | 44 |





6-Feb-2020

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | _ | Pins | _ | | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|---------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | (6) | (3) | | (4/5) | |
| ADS1191IPBS | ACTIVE | TQFP | PBS | 32 | 250 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS1191 | Samples |
| ADS1191IPBSR | ACTIVE | TQFP | PBS | 32 | 1000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS1191 | Samples |
| ADS1191IRSMR | ACTIVE | VQFN | RSM | 32 | 3000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS 1191 | Samples |
| ADS1191IRSMT | ACTIVE | VQFN | RSM | 32 | 250 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS 1191 | Samples |
| ADS1192IPBS | ACTIVE | TQFP | PBS | 32 | 250 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS1192 | Samples |
| ADS1192IPBSR | ACTIVE | TQFP | PBS | 32 | 1000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS1192 | Samples |
| ADS1192IRSMR | ACTIVE | VQFN | RSM | 32 | 3000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS 1192 | Samples |
| ADS1192IRSMT | ACTIVE | VQFN | RSM | 32 | 250 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS 1192 | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

6-Feb-2020

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| ADS1191IPBSR | TQFP | PBS | 32 | 1000 | 330.0 | 16.4 | 7.2 | 7.2 | 1.5 | 12.0 | 16.0 | Q2 |
| ADS1191IRSMR | VQFN | RSM | 32 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS1191IRSMT | VQFN | RSM | 32 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS1192IPBSR | TQFP | PBS | 32 | 1000 | 330.0 | 16.4 | 7.2 | 7.2 | 1.5 | 12.0 | 16.0 | Q2 |
| ADS1192IRSMR | VQFN | RSM | 32 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |
| ADS1192IRSMT | VQFN | RSM | 32 | 250 | 180.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |

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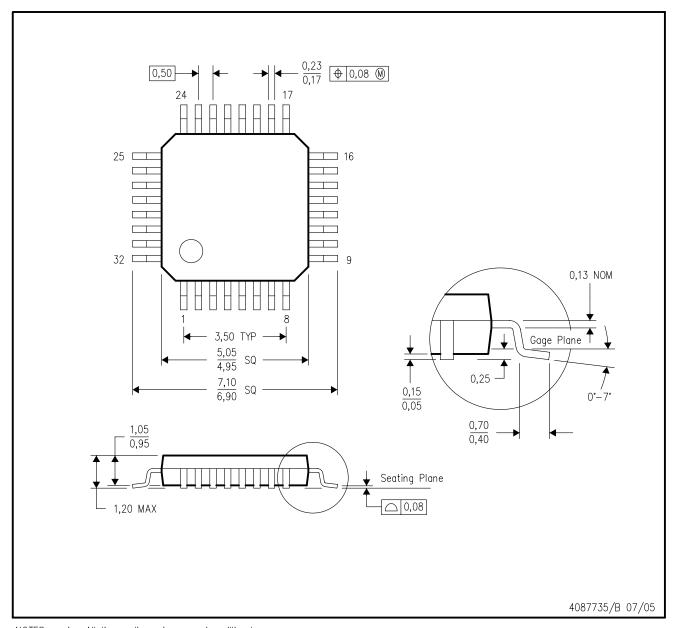


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS1191IPBSR | TQFP | PBS | 32 | 1000 | 350.0 | 350.0 | 43.0 |
| ADS1191IRSMR | VQFN | RSM | 32 | 3000 | 367.0 | 367.0 | 35.0 |
| ADS1191IRSMT | VQFN | RSM | 32 | 250 | 210.0 | 185.0 | 35.0 |
| ADS1192IPBSR | TQFP | PBS | 32 | 1000 | 350.0 | 350.0 | 43.0 |
| ADS1192IRSMR | VQFN | RSM | 32 | 3000 | 367.0 | 367.0 | 35.0 |
| ADS1192IRSMT | VQFN | RSM | 32 | 250 | 210.0 | 185.0 | 35.0 |

PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



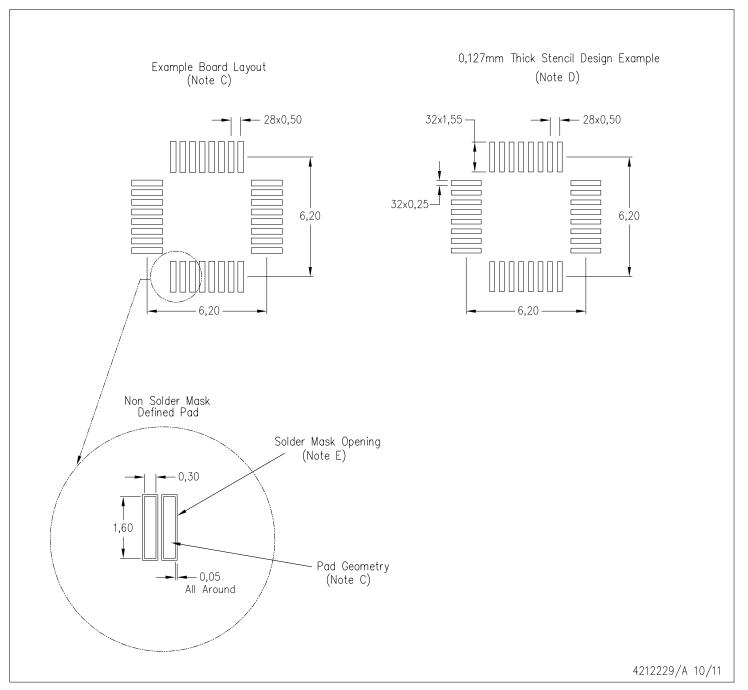
NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.



PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



NOTES:

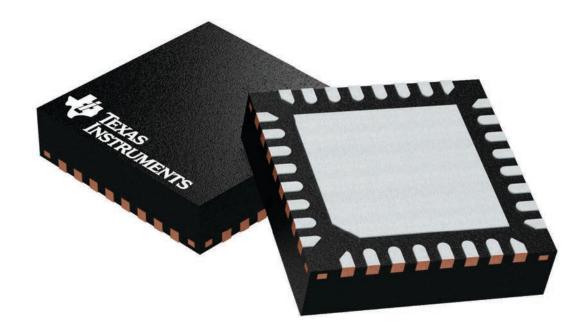
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- E. Customers should contact their board fabrication site for recommended solder mask tolerances between and around signal pads.



4 x 4, 0.4 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

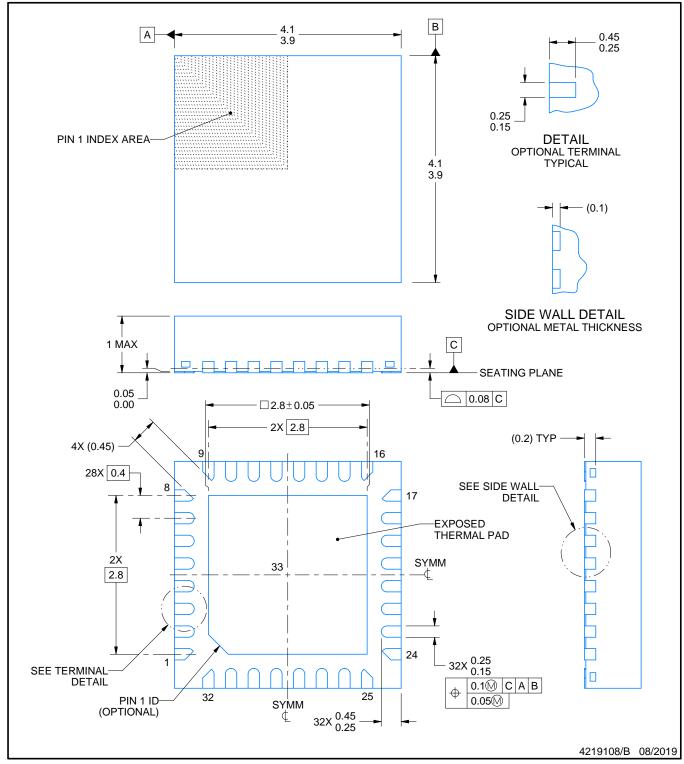
This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.







PLASTIC QUAD FLATPACK - NO LEAD



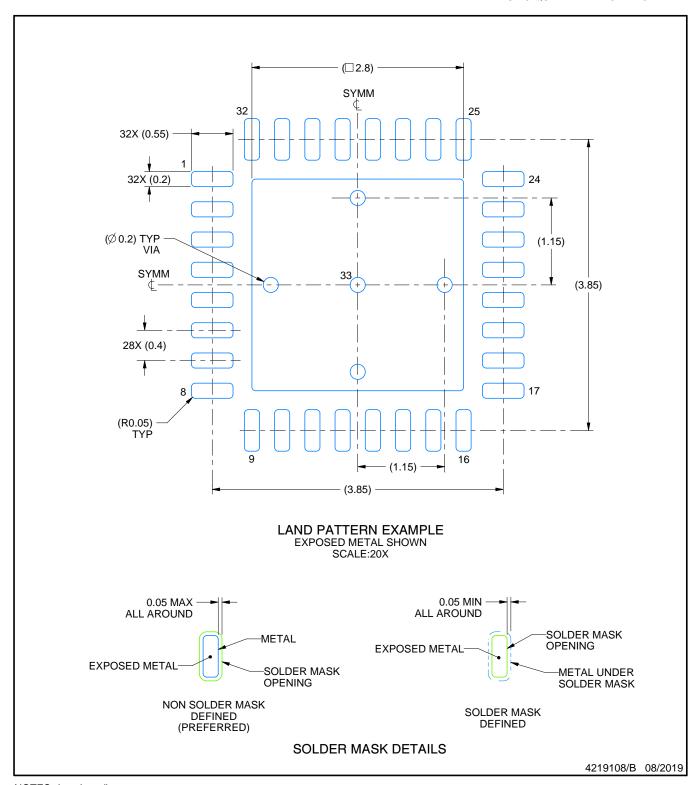
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

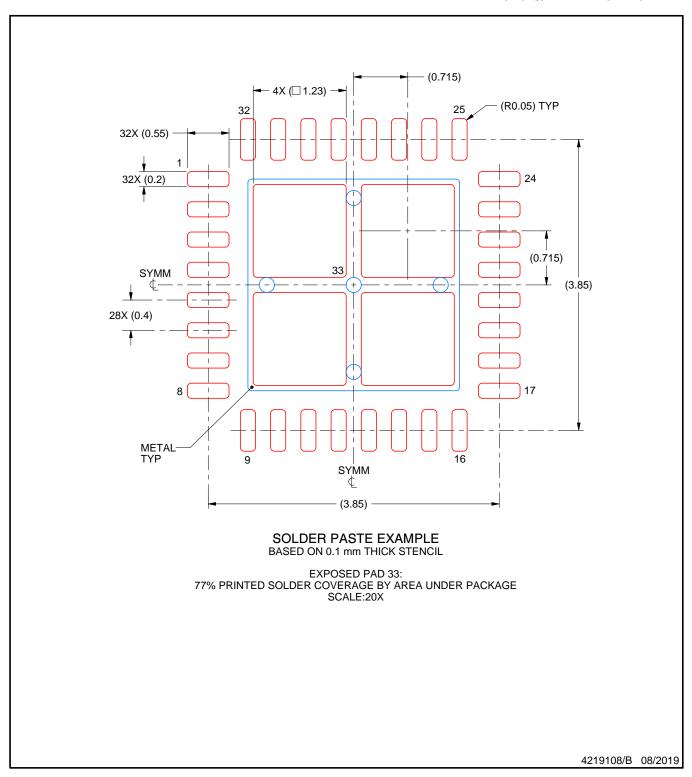


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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